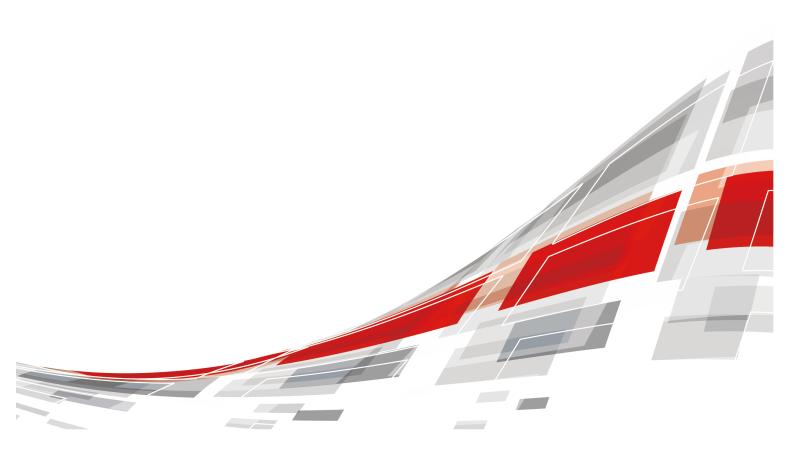
# FusionServer 5288 V6 Server

# **Technical White Paper**

Issue 13

**Date** 2024-03-29



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# **About This Document**

# **Purpose**

This document describes the FusionServer 5288 V6 rack server in terms of features, structure, specifications, and component hardware and software compatibility.

# **Intended Audience**

This document is intended for pre-sales engineers.

# **Symbol Conventions**

The symbols that may be found in this document are defined as follows.

| Symbol                   | Description   |  |
|--------------------------|---|--|
| ▲ DANGER                 | Indicates a hazard with a high level of risk which, if not avoided, will result in death or serious injury.   |  |
| <u></u> <b>⚠ WARNING</b> | Indicates a hazard with a medium level of risk which, if not avoided, could result in death or serious injury.  |  |
| <b>⚠</b> CAUTION         | Indicates a hazard with a low level of risk which, if not avoided, could result in minor or moderate injury.  |  |
| NOTICE                   | Indicates a potentially hazardous situation which, if not avoided, could result in equipment damage, data loss, performance deterioration, or unanticipated results.  NOTICE is used to address practices not related to personal injury. |  |
| NOTE                     | Supplements the important information in the main text.  NOTE is used to address information not related to personal injury, equipment damage, and environment deterioration.   |  |

# **Change History**

| Issue | Release Date | Change Description  |
|-------|--------------|---|
| 13    | 2024-03-29   | Updated 5.1.1 Appearance .  |
| 12    | 2023-11-24   | <ul> <li>Updated 10 Certifications.</li> <li>Added 11 Waste Product Recycling.</li> <li>Updated A.4 Nameplate.</li> </ul>   |
| 11    | 2023-04-30   | Updated 6.1 Technical Specifications.   |
| 10    | 2023-02-28   | Optimized 4 Logical Structure .   |
| 09    | 2023-01-18   | <ul> <li>Optimized 5.10.1 Mainboard.</li> <li>Optimized A.6 Sensor List .</li> </ul>  |
| 08    | 2022-12-16   | Updated 2 Features.   |
| 07    | 2022-11-11   | Updated 8.1 Security.   |
| 06    | 2022-09-10   | <ul> <li>Updated:</li> <li>6.2 Environmental Specifications.</li> <li>6.3 Physical Specifications.</li> <li>A.3 Operating Temperature Limitations.</li> </ul>                                   |
| 05    | 2022-08-12   | Optimized 6.3 Physical Specifications.  |
| 04    | 2022-06-25   | <ul> <li>Added a figure that shows how to measure dimensions.</li> <li>Added A.1 Chassis Label.</li> </ul>  |
|       |              | Updated A.3 Operating Temperature     Limitations.  |
|       |              | Upgrades the standards of CE, UKCA, and CCC certifications in the chapter 10 Certifications.  |
| 03    | 2022-05-18   | Added support for 5.4.2 PMem.   |
| 02    | 2022-03-18   | <ul> <li>Added 10 Certifications.</li> <li>Updated 5.4.1.6 Memory Protection<br/>Technologies.</li> <li>Updated 6.1 Technical Specifications and<br/>claimed support for U.2 drives.</li> </ul> |
| 01    | 2021-12-24   | This issue is the first official release.   |

# **Contents**

| About This Document                    | ii |
|--|----|
| 1 Overview                             | 1  |
| 2 Features                             | 2  |
| 3 Physical Structure                   | 5  |
| 4 Logical Structure                    |    |
| 5 Hardware Description                 | 9  |
| 5.1 Front Panel                        |    |
| 5.1.1 Appearance                       | g  |
| 5.1.2 Indicators and Buttons           |    |
| 5.1.3 Ports                            | 13 |
| 5.2 Rear Panel                         | 14 |
| 5.2.1 Appearance                       | 15 |
| 5.2.2 Indicators and Buttons           | 16 |
| 5.2.3 Ports                            | 18 |
| 5.3 Processors                         | 19 |
| 5.4 Memory                             | 20 |
| 5.4.1 DDR4 Memory                      | 20 |
| 5.4.1.1 Memory ID                      | 20 |
| 5.4.1.2 Memory Subsystem Architecture  | 21 |
| 5.4.1.3 Memory Compatibility           | 22 |
| 5.4.1.4 DIMM Installation Rules        | 24 |
| 5.4.1.5 Memory Installation Positions  | 25 |
| 5.4.1.6 Memory Protection Technologies | 28 |
| 5.4.2 PMem                             | 28 |
| 5.4.2.1 Memory Identifier              | 28 |
| 5.4.2.2 Memory Subsystem Architecture  | 29 |
| 5.4.2.3 Memory Compatibility           | 30 |
| 5.4.2.4 DIMM Installation Rules        | 31 |
| 5.4.2.5 Memory Installation Positions  |    |
| 5.4.2.6 Memory Protection Technologies | 33 |
| 5.5 Storage                            | 34 |

| 5.5.1 Drive Configurations            | 35  |
|---------------------------------------|-----|
| 5.5.2 Drive Numbering                 | 42  |
| 5.5.3 Drive Indicators                | 67  |
| 5.5.4 RAID Controller Card            | 70  |
| 5.6 Network                           | 70  |
| 5.6.1 OCP 3.0 Network Adapter         | 70  |
| 5.7 I/O Expansion                     | 70  |
| 5.7.1 PCle Cards                      | 70  |
| 5.7.2 PCle Slots                      | 71  |
| 5.7.3 PCle Slot Description           | 75  |
| 5.8 PSUs                              | 83  |
| 5.9 Fan Modules                       | 84  |
| 5.10 Boards                           | 85  |
| 5.10.1 Mainboard                      | 86  |
| 5.10.2 Drive Backplane                | 88  |
| 6 Product Specifications              | 93  |
| 6.1 Technical Specifications          | 93  |
| 6.2 Environmental Specifications      | 98  |
| 6.3 Physical Specifications           | 100 |
| 7 Software and Hardware Compatibility | 102 |
| 8 Safety Instructions                 | 103 |
| 8.1 Security                          |     |
| 8.2 Maintenance and Warranty          |     |
| 9 System Management                   |     |
| 10 Certifications                     |     |
|                                       |     |
| 11 Waste Product Recycling            | 111 |
| A Appendix                            | 112 |
| A.1 Chassis Label                     | 112 |
| A.1.1 On the Front Top                | 112 |
| A.1.1.1 Nameplate                     | 113 |
| A.1.1.2 Certificate                   | 114 |
| A.1.1.3 Sample Quick Access Tags      |     |
| A.1.2 Chassis Tail Label              | 116 |
| A.1.3 Chassis Internal Label          |     |
| A.2 Product SN                        | 117 |
| A.3 Operating Temperature Limitations | 119 |
| A.4 Nameplate                         | 122 |
| A.5 RAS Features                      | 122 |
| A.6 Sensor List                       |     |

| B Glossary                   | 130 |
|------------------------------|-----|
| B.1 A-E                      | 130 |
| B.2 F-J                      | 131 |
| B.3 K-O                      | 131 |
| B.4 P-T                      | 131 |
| B.5 U-Z                      | 132 |
| C Acronyms and Abbreviations | 133 |
| C.1 A-E                      | 133 |
| C.2 F-J                      | 134 |
| C.3 K-O                      | 135 |
| C.4 P-T                      | 136 |
| C.5 U-Z                      |     |

# 1 Overview

FusionServer 5288 V6 is a new-generation 4U dual-socket or single-socket storage server designed for media and entertainment, and finance fields.

The product is ideal for applications such as cold data storage, video surveillance, cloud storage, and big data processing.

The product delivers outstanding computing performance, exceptional flexibility, and unmatched storage expandability in a compact, dense design.

#### **□** NOTE

For details about the server nameplate information, see A.4 Nameplate.

Figure 1-1 Server appearance



# **2** Features

#### **Performance and Scalability**

- Powered by the third-generation Intel<sup>®</sup> Xeon<sup>®</sup> Scalable Ice Lake processors, the server provides up to 40 cores, 3.6 GHz frequency, a 60 MB L3 cache, and up to three 11.2 GT/s UPI links between the processors, which deliver supreme processing performance.
  - It supports up to two processors with 80 cores and 160 threads to maximize the concurrent execution of multithreaded applications.
  - The L2 cache capacity is increased. Each core exclusively occupies 1.25
     MB L2 cache, and at least 1.5 MB L3 cache.
  - Intel Turbo Boost Technology 2.0 allows processor cores to run faster than the frequency specified in the Thermal Design Power (TDP) configuration if they are operating below power, current, and temperature specification limits.
  - Intel Hyper-Threading Technology enables each processor core to run up to two threads, improving parallel computation capability.
  - The hardware-assisted Intel® Virtualization Technology (Intel® VT) allows operating system (OS) to better use hardware to address virtualization workloads.
  - Intel® Advanced Vector Extensions 512 (Intel AVX-512) significantly accelerates floating-point performance for computing-intensive applications.
  - Intel DL Boost (VNNI) is supported to improve the performance of deep learning applications.
  - The Intel<sup>®</sup> SGX and Intel<sup>®</sup> TME security features provide fine-grained data protection through application isolation in the memory, and defend against physical attacks through full memory encryption.
- The server supports a maximum of 32 memory modules in the following memory forms:
  - The server supports a maximum of 32 DDR4 ECC 3200 MT/s DIMMs. The DDR4 ECC DIMMs support registered DIMMs (RDIMM) and load-reduced DIMMs (LRDIMMs), which provide high speed and availability. A server supports a maximum memory capacity of 4096 GB and a maximum memory bandwidth of 400 GB/s in theory.
  - The server supports a maximum of 16 Intel<sup>®</sup> Optane<sup>TM</sup> Persistent Memory Module 200 series (PMem modules for short), which must be used with the

DDR4 memory modules. When the DDR4 memory modules are used together, the server supports a maximum of 12 TB memory capacity (calculated based on a maximum of 256 GB capacity per DDR4 memory module and a maximum of 512 GB capacity per PMem module).

- Flexible drive configurations meet a variety of business requirements and ensure high elasticity and scalability of storage resources.
- The use of 12 Gbit/s SCSI (SAS) serial connection for internal storage provides 2x data transmission rate than the use of 6 Gbit/s SAS connection, maximizing the performance of I/O-intensive applications.
- With Intel integrated I/O, the third-generation Intel<sup>®</sup> Xeon<sup>®</sup> Scalable processors integrate the PCIe 4.0 controller to shorten I/O latency and improve overall system performance.
- The server supports a maximum of eight PCle 4.0 expansion slots.
- The server supports two FlexIO cards (applicable to the OCP 3.0 network adapter) with flexible configuration of GE/10GE/25GE/100GE network adapters, which are hot swappable.

#### **Availability and Serviceability**

- Carrier-class components with process expertise ensure high system reliability and availability.
- The server supports hot-swappable SAS/SATA/NVMe drives. SAS/SATA drives support RAID 0, 1, 10, 5, 50, 6, and 60, depending on the RAID controller card used. It also uses a supercapacitor to protect the RAID cache data against power failures.
- SSDs offer better reliability than HDDs, prolonging system uptime.
- The server provides simplified O&M and efficient troubleshooting through the UID/HLY indicators on the front panel, fault diagnosis LED, and iBMC WebUI.
- The mounting ears provide iBMC direct connect management ports to support local iBMC O&M, improving O&M efficiency.
- A server provides two hot-swappable PSUs in 1+1 redundancy mode and four hot-swappable fan modules in N+1 redundancy mode, improving system availability.
- The built-in iBMC monitors system parameters in real time, triggers alarms, and performs recovery actions to minimize the system downtime.

## Manageability and Security

- The built-in iBMC monitors server operating status and provides remote management.
- A password is required for accessing the BIOS, ensuring system boot and management security.
- The NC-SI feature allows a network port to serve as a management port and a service port. The NC-SI feature is disabled by default and can be enabled through the iBMC or BIOS.
- The integrated Unified Extensible Firmware Interface (UEFI) improves setup, configuration, and update efficiency and simplifies fault handling.
- The server chassis panel ensures security of local data.

- Chassis cover opening detection is supported to enhance security.
- Intel Execute Disable Bit (EDB) function prevents certain types of malicious buffer overflow attacks when working with a supported OS.
- The Intel Converged Boot Guard & Trusted Execution Technology (Intel CBnT) prevents malicious software attacks based on hardware, prevents the firmware from being maliciously modified, and prevents the execution of unauthorized boot blocks. It also allows applications to run in their own independent space without being affected by other software running in the system, thereby enhancing security.
- The secure boot based on the chip RoT implements level-by-level firmware verification starting from the hardware RoT and builds a complete secure boot chain
- The trusted platform module (TPM) and trusted cryptography module (TCM) provide advanced encryption functions, such as digital signatures and remote authentication.
- The following requirements in NIST SP 800-147B are met:
  - The BIOS firmware digital signature update mechanism is supported. During the upgrade, the digital signature is verified to prevent unauthorized BIOS firmware upgrade.
  - The flash security protection mechanism is supported to prevent unauthorized modification of the flash memory in the OS.

#### **◯** NOTE

The service port with NC-SI enabled supports the following configuration:

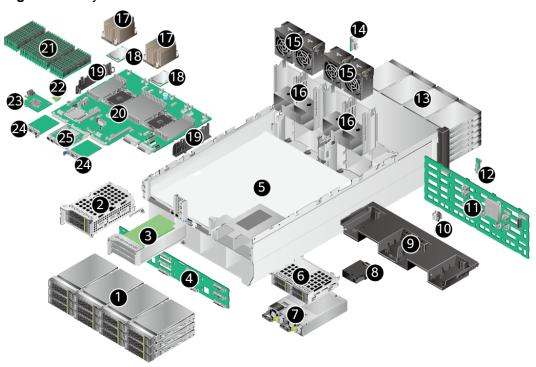
- Configuring any network port on the FlexIO card 1, FlexIO card 2, or PCle NIC (with NC-SI enabled).
- Enabling, disabling, and setting a virtual local area network (VLAN) ID for this port. The VLAN ID is **0** and disabled by default.
- Configuring IPv4 addresses (IPv4 address, subnet mask, and gateway) and IPv6 addresses (IPv6 address, prefix length, and gateway) for this port.

#### **Energy Efficiency**

- The server supports 80 Plus Platinum/Titanium PSUs of different energy efficiency levels. The PSU efficiency reaches 96% at 50% load.
- Active/standby power supply and HVDC power supply are supported, improving the efficiency of the power supply system.
- Efficient voltage regulator-down (VRD) power supplies for boards minimize the energy loss from DC/DC power conversion.
- Area-based, Proportional-Integral-Derivative (PID) intelligent fan speed adjustment and intelligent CPU frequency scaling optimize heat dissipation and reduce overall system power consumption.
- The improved thermal design with energy-efficient fans ensures optimal heat dissipation and reduces system power consumption.
- The server is protected with power capping and power control measures.
- Staggered spin-up of drives reduces the server boot power consumption.

# 3 Physical Structure

Figure 3-1 Physical structure

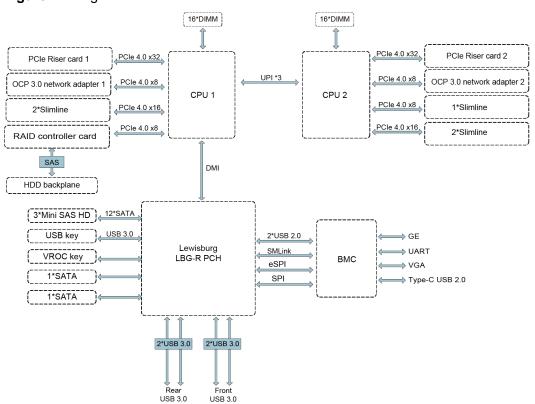


| 1 | Rear drive  | 2  | I/O module 1          |
|---|---|----|-----------------------|
| 3 | I/O module 2  | 4  | Rear-drive backplane  |
| 5 | Chassis   | 6  | I/O module 3          |
| 7 | PSU   | 8  | Supercapacitor holder |
| 9 | Air duct  NOTE  You are not allowed to install the air duct on a server with built-in drives. | 10 | Intrusion sensor      |

| 11 | Front-drive backplane         | 12 | Left mounting ear plate  |
|----|-------------------------------|----|--------------------------|
| 13 | Front drive                   | 14 | Right mounting ear plate |
| 15 | Fan module                    | 16 | Fan module brackets      |
| 17 | Processor heat sink           | 18 | Processor                |
| 19 | Cable organizer               | 20 | Mainboard                |
| 21 | Memory                        | 22 | TPM/TCM                  |
| 23 | Screw-in RAID controller card | 24 | OCP 3.0 network adapter  |
| 25 | BMC card                      | -  | -                        |

# 4 Logical Structure

Figure 4-1 Logical structure



- The server supports one or two third-generation Intel<sup>®</sup> Xeon<sup>®</sup> Scalable Ice Lake processors.
- The server supports up to 32 memory modules.
- The CPUs (processors) interconnect with each other through three UPI links at a speed of up to 11.2 GT/s.
- The PCIe riser card connects to the processors through PCIe buses to provide ease of expandability and connection.
- CPU1 and CPU2 each support one OCP 3.0 network adapter.
- The screw-in RAID controller card on the mainboard connects to CPU 1 through PCIe buses, and connects to the drive backplane through SAS high-speed

- cables. A variety of drive backplanes are provided to support different local storage configurations.
- The LBG-R Platform Controller Hub (PCH) is integrated on the mainboard to support five USB 3.0 ports.
- The BMC management chip integrated on the mainboard supports ports such as a video graphic array (VGA) port, a management network port, and a serial port.

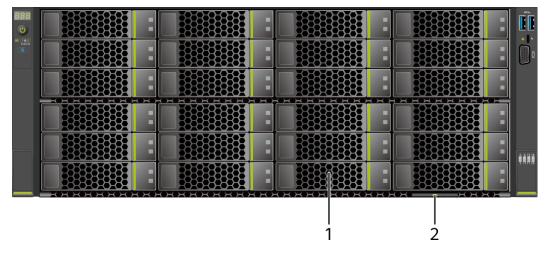
# 5 Hardware Description

- 5.1 Front Panel
- 5.2 Rear Panel
- 5.3 Processors
- 5.4 Memory
- 5.5 Storage
- 5.6 Network
- 5.7 I/O Expansion
- 5.8 PSUs
- 5.9 Fan Modules
- 5.10 Boards

# **5.1 Front Panel**

# 5.1.1 Appearance

Figure 5-1 Front view



| 1 | Drive | 2 | Slide-out label plate (with |
|---|-------|---|-----------------------------|
|   |       |   | an SN label)                |

# 5.1.2 Indicators and Buttons

## **Indicator and Button Positions**

Figure 5-2 Indicators and buttons on the front panel



| 1 | Fault diagnosis LED                           | 2 | Power button/indicator           |
|---|---|---|----------------------------------|
| 3 | Health status indicator                       | 4 | UID button/indicator             |
| 5 | FlexIO card 1 presence indicator              | 6 | FlexIO card 2 presence indicator |
| 7 | iBMC direct connect management port indicator | - | -                                |

# **Indicator and Button Descriptions**

Table 5-1 Description of indicators and buttons on the front panel

| Silkscreen | Indicator and<br>Button | Description  |
|------------|-------------------------|--|
| 888        | Fault<br>diagnosis LED  | <ul> <li>: The device is operating properly.</li> <li>Error code: A component is faulty. For details about error codes, see the <i>iBMC Alarm Handling</i>.</li> </ul> |

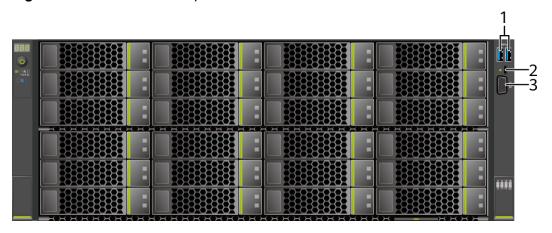
| Silkscreen | Indicator and Button     | Description  |
|------------|--------------------------|--|
| ტ          | Power button/            | Power indicator:   |
|            | indicator                | Off: The device is not powered on.   |
|            |                          | Steady green: The device is powered on.  |
|            |                          | Blinking yellow: The iBMC is starting. The power button is locked and cannot be pressed. The iBMC is started in about 1 minute, and then the power indicator is steady yellow. |
|            |                          | Steady yellow: The device is standby.  |
|            |                          | Power button:  |
|            |                          | When the device is powered on, you can<br>press this button to gracefully shut down the<br>OS.   |
|            |                          | NOTE For different OSs, you may need to shut down the OS as prompted.  |
|            |                          | <ul> <li>When the device is powered on, you can hold<br/>down this button for 6 seconds to forcibly<br/>power off the device.</li> </ul>                                       |
|            |                          | When the power indicator is steady yellow,<br>you can press this button to power on the<br>device.   |
| M          | Health status            | Off: The device is powered off or is faulty.   |
|            | indicator                | Blinking red at 1 Hz: A major alarm has been generated on the system.  |
|            |                          | Blinking red at 5 Hz: A critical alarm has been generated on the system.   |
|            |                          | Steady green: The device is operating properly.  |
| <b>@</b>   | UID button/<br>indicator | The UID button/indicator helps identify and locate a device.   |
|            |                          | UID indicator:   |
|            |                          | Off: The device is not being located.  |
|            |                          | Blinking or steady blue: The device is being located.  |
|            |                          | UID button:  |
|            |                          | You can control the UID indicator status by pressing the UID button or using the iBMC.   |
|            |                          | You can press this button to turn on or off the UID indicator.   |
|            |                          | You can press and hold down this button for 4 to 6 seconds to reset the iBMC.  |

| Silkscreen | Indicator and Button                          | Description  |
|------------|---|--|
| **         | FlexIO card<br>presence<br>indicator          | <ul> <li>Indicates whether the FlexIO card is detected.</li> <li>Off: The FlexIO card is not detected.</li> <li>Blinking green at 0.5 Hz: The FlexIO card is detected but is not powered on.</li> <li>Blinking green at 2 Hz: The FlexIO card is detected and has just been inserted.</li> <li>Steady green: The FlexIO card is detected and the power supply is normal.</li> </ul>  |
|            | iBMC direct connect management port indicator | <ul> <li>Indicates the status when the iBMC direct connect management port connects to a terminal (local PC or Android mobile phone):</li> <li>Off: No terminal is connected.</li> <li>Blinking green at short intervals for 3 seconds and then off: The port is disabled.</li> <li>Steady green: The terminal is connected.</li> <li>Indicates the status when the iBMC direct connect management port connects to a USB device:</li> <li>Blinking red at long intervals: The job fails or an error is reported when the job is complete.</li> <li>Blinking green at short intervals: The job is being executed.</li> <li>Blinking green at short intervals for 3 seconds and then off: The port is disabled.</li> <li>Steady green: The server configuration file is being copied from the USB device or the job is successfully completed.</li> </ul> |

# **5.1.3 Ports**

#### **Port Positions**

Figure 5-3 Ports on the front panel



| 1 | USB 3.0 port | 2 | iBMC direct connect management port |
|---|--------------|---|-------------------------------------|
| 3 | VGA port     | - | -                                   |

# **Port Description**

Table 5-2 Ports on the front panel

| Port     | Туре    | Quantity | Description  |
|----------|---------|----------|--|
| USB port | USB 3.0 | 2        | Used to connect to a USB 3.0 device.  NOTICE   |
|          |         |          | Before connecting an external USB device, ensure that the USB device functions properly. Otherwise, it may adversely impact the server.  |
|          |         |          | The USB 3.0 port can be used to supply power to low-power peripherals. However, the USB 3.0 port must comply with the USB specifications. To run advanced peripherals, such as external CD/DVD drives, an external power supply is required. |

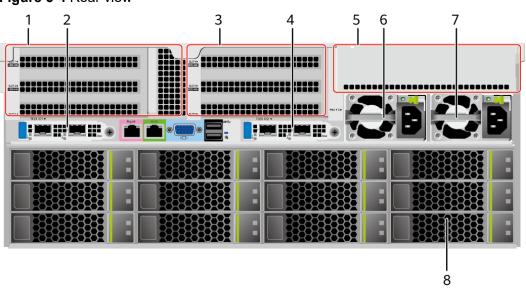
| Port   | Туре   | Quantity | Description  |
|--|--|----------|--|
| iBMC direct<br>connect<br>management<br>port <sup>Note</sup> | USB Type-C  NOTE  The USB 2.0 protocol is supported. | 1        | Used to connect to a local PC or mobile phone through a USB Type-C cable to monitor and manage the system.  NOTE  Only local PCs running Windows 10 and mobile phones running Android are supported.  • To log in to the iBMC from the local PC, enter https://I/P address of the iBMC management network port in the address box of the browser on the local PC.  • When accessing the iBMC through a mobile phone, you need to use the mobile application FusionMobile to access the iBMC. For details, see the FusionMobile User Guide. |
| VGA port <sup>Note</sup>                                     | DB15   | 1        | Used to connect a display terminal, such as a monitor or KVM.  |

Note: The VGA port and iBMC direct connect management port cannot be used at the same time.

# 5.2 Rear Panel

# 5.2.1 Appearance

Figure 5-4 Rear view



| 1 | I/O module 1   | 2 | (Optional) FlexIO card 1   |
|---|----------------|---|--|
|   |                |   | NOTE  The FlexIO card slot supports only OCP 3.0 network adapters.                           |
| 3 | I/O module 2   | 4 | (Optional) FlexIO card 2  NOTE  The FlexIO card slot supports only OCP 3.0 network adapters. |
| 5 | I/O module 3   | 6 | PSU 1  |
| 7 | Power supply 2 | 8 | Rear drive   |

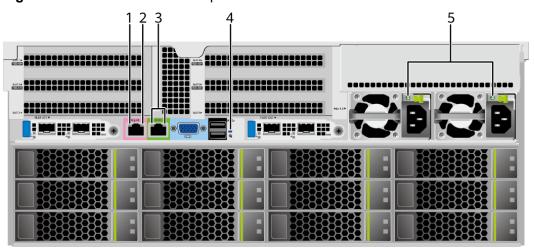
#### **◯** NOTE

- I/O module 1 and I/O module 2 each support a PCle riser module, 2 x 3.5" rear-drive module, or module with 2 x 2.5" rear drives and one PCle riser card.
- I/O module 3 supports a PCle riser module or 4 x 2.5" rear-drive module.
- For details about the OCP 3.0 network adapter, see 5.6.1 OCP 3.0 Network Adapter.
- The figure is for reference only. The actual configuration may vary.

# 5.2.2 Indicators and Buttons

#### **Indicator Positions**

Figure 5-5 Indicators on the rear panel



| 1 | Data transmission status indicator of the management network port | 2 | Connection status indicator of the management network port |
|---|---|---|--|
| 3 | Serial port indicator  NOTE  Reserved and unavailable currently.  | 4 | UID indicator  |
| 5 | PSU indicator   | - | -  |

# **Indicator Description**

Table 5-3 Description of indicators on the rear panel

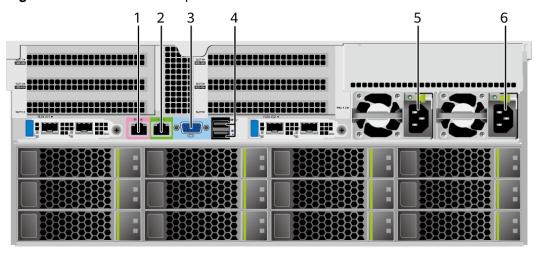
| Silkscreen | Indicator   | Description  |
|------------|---|--|
| -          | Data transmission<br>status indicator for<br>the management<br>network port | <ul><li> Off: No data is being transmitted.</li><li> Blinking yellow: Data is being transmitted.</li></ul>                 |
| -          | Connection status indicator of the management network port                  | <ul> <li>Off: The network port is not connected.</li> <li>Steady green: The network port is connected properly.</li> </ul> |

| Silkscreen | Indicator     | Description  |
|------------|---------------|--|
| <b>@</b>   | UID indicator | The UID indicator helps identify and locate a device.                                  |
|            |               | Off: The device is not being located.  |
|            |               | Blinking or steady blue: The device is being located.                                  |
|            |               | NOTE   |
|            |               | You can control the UID indicator status by pressing the UID button or using the iBMC. |
| -          | PSU indicator | Off: No power is supplied.   |
|            |               | Blinking green at 1 Hz:  |
|            |               | <ul> <li>The input is normal, and the server is standby.</li> </ul>                    |
|            |               | <ul> <li>The input is overvoltage or undervoltage.</li> </ul>                          |
|            |               | <ul> <li>The PSU is in deep hibernation mode.</li> </ul>                               |
|            |               | Blinking green at 4 Hz: The firmware is being upgraded online.                         |
|            |               | Steady green: The power input and output are normal.                                   |
|            |               | Steady orange: The input is normal but there is no output.                             |
|            |               | NOTE  The possible causes of no power output are as follows:                           |
|            |               | Power supply overtemperature protection  |
|            |               | Power output overcurrent or short-<br>circuit  |
|            |               | Output overvoltage   |
|            |               | Short-circuit protection   |
|            |               | Device failure (excluding failure of all devices)                                      |

### **5.2.3 Ports**

#### **Port Positions**

Figure 5-6 Ports on the rear panel



| 1 | Management network port | 2 | Serial port      |
|---|-------------------------|---|------------------|
| 3 | VGA port                | 4 | USB 3.0 port     |
| 5 | Socket for PSU 1        | 6 | Socket for PSU 2 |

# **Port Description**

Table 5-4 Description of ports on the rear panel

| Port                    | Туре | Quantity | Description   |
|-------------------------|------|----------|---|
| Management network port | RJ45 | 1        | iBMC management network port, which is used to manage the server.   |
|                         |      |          | NOTE  The management network port is a GE port that supports 100 Mbit/s and 1000 Mbit/s auto-negotiation.                       |
| Serial port             | RJ45 | 1        | Default operating system serial port used for debugging. You can also set it as the iBMC serial port by using the iBMC command. |
|                         |      |          | NOTE The port uses 3-wire serial communication interface, and the default baud rate is 115,200 bit/s.                           |

| Port       | Туре    | Quantity | Description  |
|------------|---------|----------|--|
| VGA port   | DB15    | 1        | Used to connect a display terminal, such as a monitor or KVM.  |
| USB port   | USB 3.0 | 2        | Used to connect to a USB 3.0 device.   |
|            |         |          | NOTICE   |
|            |         |          | The maximum current is 1.3 A for an external USB device.   |
|            |         |          | <ul> <li>Before connecting an external<br/>USB device, ensure that the<br/>USB device functions properly.<br/>Otherwise, it may adversely<br/>impact the server.</li> </ul>  |
|            |         |          | The USB 3.0 port can be used to supply power to low-power peripherals. However, the USB 3.0 port must comply with the USB specifications. To run advanced peripherals, such as external CD/DVD drives, an external power supply is required. |
| PSU socket | -       | 2        | Used to connect to a power distribution unit (PDU) through a power cable. You can select the PSUs as required.   |
|            |         |          | When determining the PSUs, ensure that the rated power of the PSUs is greater than that of the server.   |

# **5.3 Processors**

- The server supports one or two processors.
- If only one processor is required, install it in socket CPU1.
- Processors of the same model must be used in a server.
- For details about the optional components, consult the local sales representative or see "Search Parts" in the compatibility list on the technical support website.

CPU2

Figure 5-7 Processor positions

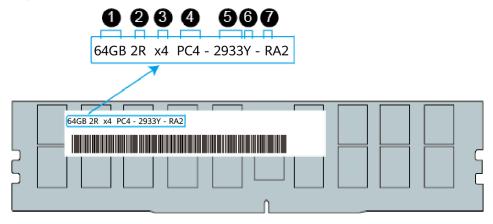
# **5.4 Memory**

# 5.4.1 DDR4 Memory

# 5.4.1.1 Memory ID

You can determine the memory module properties based on the label attached to the memory module.

Figure 5-8 Memory identifier



| No. | Description                             | Example  |
|-----|---|--|
| 1   | Capacity                                | <ul> <li>16 GB</li> <li>32 GB</li> <li>64 GB</li> <li>128 GB</li> <li>256 GB</li> </ul>              |
| 2   | Number of ranks                         | <ul><li>1R: single-rank</li><li>2R: dual-rank</li><li>4R: quad-rank</li><li>8R: octal-rank</li></ul> |
| 3   | Data width on the DRAM                  | <ul><li>x4: 4-bit</li><li>x8: 8-bit</li></ul>  |
| 4   | Type of the memory interface            | PC4: DDR4  |
| 5   | Maximum memory speed                    | <ul><li>2933 MT/s</li><li>3200 MT/s</li></ul>  |
| 6   | Memory latency parameters (CL-tRCD-tRP) | <ul> <li>W = 20-20-20</li> <li>Y = 21-21-21</li> <li>AA = 22-22-22</li> </ul>                        |
| 7   | DIMM type                               | <ul><li>R = RDIMM</li><li>L = LRDIMM</li></ul>   |

# **5.4.1.2 Memory Subsystem Architecture**

A server provides 32 memory slots. Each processor integrates eight memory channels.

Install the memory modules in the primary memory channels first. If the primary memory channel is not populated, the memory modules in secondary memory channels cannot be used.

Table 5-5 Memory channels

| СРИ   | Channel     | Memory Slot |
|-------|-------------|-------------|
| CPU 1 | A (primary) | DIMM000(A)  |
|       | А           | DIMM001(I)  |
|       | B (primary) | DIMM010(B)  |
|       | В           | DIMM011(J)  |
|       | C (primary) | DIMM020(C)  |

| CPU  | Channel     | Memory Slot |
|------|-------------|-------------|
|      | С           | DIMM021(K)  |
|      | D (primary) | DIMM030(D)  |
|      | D           | DIMM031(L)  |
|      | E (primary) | DIMM040(E)  |
|      | Е           | DIMM041(M)  |
|      | F (primary) | DIMM050(F)  |
|      | F           | DIMM051(N)  |
|      | G (primary) | DIMM060(G)  |
|      | G           | DIMM061(O)  |
|      | H (primary) | DIMM070(H)  |
|      | Н           | DIMM071(P)  |
| CPU2 | A (primary) | DIMM100(A)  |
|      | A           | DIMM101(I)  |
|      | B (primary) | DIMM110(B)  |
|      | В           | DIMM111(J)  |
|      | C (primary) | DIMM120(C)  |
|      | С           | DIMM121(K)  |
|      | D (primary) | DIMM130(D)  |
|      | D           | DIMM131(L)  |
|      | E (primary) | DIMM140(E)  |
|      | Е           | DIMM141(M)  |
|      | F (primary) | DIMM150(F)  |
|      | F           | DIMM151(N)  |
|      | G (primary) | DIMM160(G)  |
|      | G           | DIMM161(O)  |
|      | H (primary) | DIMM170(H)  |
|      | Н           | DIMM171(P)  |

# **5.4.1.3 Memory Compatibility**

Observe the following rules when configuring DDR4 memory modules:

#### **NOTICE**

- A server must use DDR4 memory modules of the same part number (P/N code), and the memory speed is the minimum value of the following items:
  - Memory speed supported by a CPU
  - Maximum operating speed of a memory module
- The DDR4 DIMMs of different types (RDIMM and LRDIMM) and specifications (capacity, bit width, rank, and height) cannot be used together.
- Contact your local sales representative or see "Search Parts" in the compatibility list on the technical support website to determine the components to be used.
- The memory can be used with the third-generation Intel<sup>®</sup> Xeon<sup>®</sup> Scalable Ice Lake processors. The maximum memory capacity supported by all processor models is the same.
- The total memory capacity is the sum of the capacity of all DDR4 DIMMs.

#### NOTICE

The total memory capacity refers to the capacity when DDR4 memory modules are fully configured. For details about the memory capacity when PMem modules are used together with DDR4 memory modules, see **5.4.2.3 Memory Compatibility**.

- For details about the capacity type of a single memory module, see "Search Parts" in the compatibility list on the technical support website.
- The maximum number of memory modules supported depends on the memory type and rank quantity.

#### **◯** NOTE

Each memory channel supports a maximum of 8 ranks. The number of memory modules supported by each channel varies depending on the number of ranks supported by each channel:

Number of memory modules supported by each channel ≤ Number of ranks supported by each memory channel/Number of ranks supported by each memory module

A memory channel supports more than eight ranks for LRDIMMs.

#### **NOTE**

A quad-rank LRDIMM generates the same electrical load as a single-rank RDIMM on a memory bus.

Table 5-6 DDR4 memory specifications

| Parameter                            | Specifications |       |       |        |  |
|--------------------------------------|----------------|-------|-------|--------|--|
| Capacity per DDR4 memory module (GB) | 16             | 32    | 64    | 128    |  |
| Туре                                 | RDIMM          | RDIMM | RDIMM | LRDIMM |  |

| Parameter   |                   | Specifications |      |      |      |  |
|---|-------------------|----------------|------|------|------|--|
| Rated speed (MT/s)                                    |                   | 3200           | 3200 | 3200 | 3200 |  |
| Operating vo  | Itage (V)         | 1.2            | 1.2  | 1.2  | 1.2  |  |
| Maximum number of DDR4 DIMMs in a server <sup>a</sup> |                   | 32             | 32   | 32   | 32   |  |
| Maximum DDR4 memory capacity of the server (GB)       |                   | 512            | 1024 | 2048 | 4096 |  |
| Actual rate (MT/s)                                    | 1DPC <sup>b</sup> | 3200           | 3200 | 3200 | 3200 |  |
|   | 2DPC              | 3200           | 3200 | 3200 | 3200 |  |

- a: The maximum number of DDR4 memory modules is based on dualprocessor configuration. The value is halved for a server with only one processor.
- b: DPC (DIMM per channel) indicates the number of memory modules per channel.
- The information listed in this table is for reference only. For details, consult the local sales representative.

#### 5.4.1.4 DIMM Installation Rules

#### ■ NOTE

This section applies to a server fully configured with DDR4 memory modules. If PMem modules are used together, see **5.4.2.5 Memory Installation Positions** .

Observe the following when configuring DDR4 memory modules:

- Install memory modules only when corresponding processors are installed.
- Do not install LRDIMMs and RDIMMs in the same server.
- Install filler memory modules in vacant slots.

Observe the following when configuring DDR4 memory modules in specific operating mode:

- Rank sparing mode
  - Comply with the general installation guidelines.
  - At least two ranks must be configured for each channel.
  - A maximum of two standby ranks can be configured for each channel.
  - The capacity of a standby rank must be greater than or equal to that of other ranks in the same channel.
- Memory mirroring mode
  - Comply with the general installation guidelines.
  - Each processor supports four integrated memory controllers (IMCs), and each IMC has two channels for installing memory modules. The installed memory modules must be identical in size and organization.

- For a multi-processor configuration, each processor must have a valid memory mirroring configuration.
- Memory scrubbing mode
  - Comply with the general installation guidelines.

### **5.4.1.5 Memory Installation Positions**

A server supports a maximum of 32 DDR4 memory modules. To maximize performance, balance the total memory capacity between the installed processors and to load the channels similarly whenever possible.

Observe the memory module installation rules when configuring memory modules. For details, see the *Memory Configuration Guide* of the server on the technical support website.

#### NOTICE

At least one DDR4 memory module must be installed in the primary memory channels corresponding to CPU 1.

Figure 5-9 Memory slots

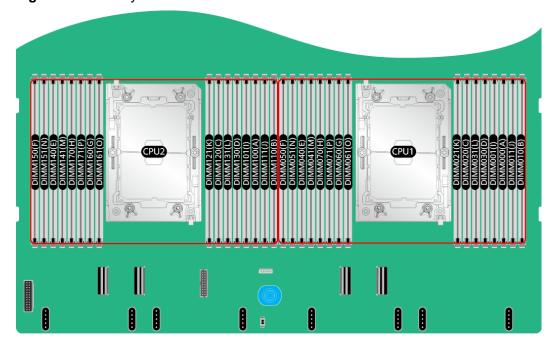


Figure 5-10 DDR4 memory module installation guidelines (1 processor)

|       |             |  |           |             | Number of DIMMs |          |    |  |             |          |  |  |
|-------|-------------|--|-----------|-------------|-----------------|----------|----|--|-------------|----------|--|--|
| CPU   | Channel     | DIMM Slot (\sqrt{: recommended} O: not recom |           |             |                 |          |    |  | nmended)    |          |  |  |
| Ci U  | Chamile     | Dilvilvi Stot                                | <         | <b>&gt;</b> | ✓               | ✓        | ✓  | ✓  | 0           | <b>\</b> |  |  |
|       |             |  | 1         | 2           | 4               | 6        | 8  | 12   | 12          | 16       |  |  |
|       | Α           | DIMM000(A)                                   | •         | •           | •               | •        | •  | •  | •           | •        |  |  |
|       | A           | DIMM001(I)                                   |           |             |                 |          |    | •  | •           | •        |  |  |
|       | -           | DIMM010(B)                                   |           |             |                 | •        | •  | •  | •           | •        |  |  |
|       | В           | DIMM011(J)                                   |           |             |                 |          |    | •  |             | •        |  |  |
|       |             | DIMM020(C)                                   |           |             | •               | •        | •  | •  | •           | •        |  |  |
|       | С           | DIMM021(K)                                   |           |             |                 |          |    | •  | •           | •        |  |  |
|       |             | DIMM030(D)                                   |           |             |                 |          | •  |  | •           | •        |  |  |
| CDIIA | D           | DIMM031(L)                                   |           |             |                 |          |    |  |             | •        |  |  |
| CPU1  | Е           | DIMM040(E)                                   |           | •           | •               | •        | •  | •  | •           | •        |  |  |
|       | E           | DIMM041(M)                                   |           |             |                 |          |    | •  | •           | •        |  |  |
|       | _           | DIMM050(F)                                   |           |             |                 | •        | •  | •  | •           | •        |  |  |
|       | F           | DIMM051(N)                                   |           |             |                 |          |    | •  |             | •        |  |  |
|       |             | DIMM060(G)                                   |           |             | •               | •        | •  | •  | •           | •        |  |  |
|       | G           | DIMM061(O)                                   |           |             |                 |          |    | •  | •           | •        |  |  |
|       | - 11        | DIMM070(H)                                   |           |             |                 |          | •  |  | •           | •        |  |  |
|       | Н           | DIMM071(P)                                   |           |             |                 |          |    |  |             | •        |  |  |
|       |             | Ms are configured, the                       |           |             |                 |          |    |  |             |          |  |  |
| Note  |             | lation that is not recom                     |           | •           |                 |          | -  | installatio  | n that is r | ot       |  |  |
|       | recommended | (marked with ○) supp                         | orts SNC. | z, Hemi, S  | SGX, and        | UMA X-SK | t. | recommended (marked with ○) supports SNC2, Hemi, SGX, and UMA X-skt. |             |          |  |  |

Figure 5-11 DDR4 memory module installation guidelines (2 processors)

|       | Number of DIMMs |                                       |  |             |             |      |      |          |    |          |
|-------|-----------------|---------------------------------------|--|-------------|-------------|------|------|----------|----|----------|
| CPU   | Channel         | DIMM Slot                             | MM Slot (√: recommended ○: not recommended |             |             | meno | led) |          |    |          |
| CPU   | Chamilet        | DIIVIIVI SLOC                         | ✓  | <b>&gt;</b> | <b>&gt;</b> | ✓    | ✓    | <b>√</b> | 0  | <b>√</b> |
|       |                 |                                       | 2  | 4           | 8           | 12   | 16   | 24       | 24 | 32       |
|       | Α               | DIMM000(A)                            | •  | •           | •           | •    | •    | •        | •  | •        |
|       | ^               | DIMM001(I)                            |  |             |             |      |      | •        | •  | •        |
|       | В               | DIMM010(B)                            |  |             |             | •    | •    | •        | •  | •        |
|       | Ь               | DIMM011(J)                            |  |             |             |      |      | •        |    | •        |
|       | С               | DIMM020(C)                            |  |             | •           | •    | •    | •        | •  | •        |
|       | C               | DIMM021(K)                            |  |             |             |      |      | •        | •  | •        |
|       | D               | DIMM030(D)                            |  |             |             |      | •    |          | •  | •        |
| CPU1  | D               | DIMM031(L)                            |  |             |             |      |      |          |    | •        |
| J. 01 | Е               | DIMM040(E)                            |  | •           | •           | •    | •    | •        | •  | •        |
|       | _               | DIMM041(M)                            |  |             |             |      |      | •        | •  | •        |
|       | F               | DIMM050(F)                            |  |             |             | •    | •    | •        | •  | •        |
|       | <b>'</b>        | DIMM051(N)                            |  |             |             |      |      | •        |    | •        |
|       | G               | DIMM060(G)                            |  |             | •           | •    | •    | •        | •  | •        |
|       | J               | DIMM061(O)                            |  |             |             |      |      | •        | •  | •        |
|       | Н               | DIMM070(H)                            |  |             |             |      | •    |          | •  | •        |
|       |                 | DIMM071(P)                            |  |             |             |      |      |          |    | •        |
|       | Α               | DIMM100(A)                            | •  | •           | •           | •    | •    | •        | •  | •        |
|       | , <b>,</b>      | DIMM101(I)                            |  |             |             |      |      | •        | •  | •        |
|       | В               | DIMM110(B)                            |  |             |             | •    | •    | •        | •  | •        |
|       | J               | DIMM111(J)                            |  |             |             |      |      | •        |    | •        |
|       | С               | DIMM120(C)                            |  |             | •           | •    | •    | •        | •  | •        |
|       | ŭ               | DIMM121(K)                            |  |             |             |      |      | •        | •  | •        |
|       | D               | DIMM130(D)                            |  |             |             |      | •    |          | •  | •        |
| CPU2  |                 | DIMM131(L)                            |  |             |             |      |      |          |    | •        |
|       | Е               | DIMM140(E)                            |  | •           | •           | •    | •    | •        | •  | •        |
|       | _               | DIMM141(M)                            |  |             |             |      |      | •        | •  | •        |
|       | F               | DIMM150(F)                            |  |             |             | •    | •    | •        | •  | •        |
|       |                 | DIMM151(N)                            |  |             |             |      |      | •        |    | •        |
|       | G               | DIMM160(G)                            |  |             | •           | •    | •    | •        | •  | •        |
|       |                 | DIMM161(O)                            |  |             |             |      |      | •        | •  | •        |
|       | н               | DIMM170(H)                            |  |             |             |      | •    |          | •  | •        |
|       |                 | DIMM171(P)  Ms are configured, the re |  |             |             |      |      |          |    | •        |

#### **5.4.1.6 Memory Protection Technologies**

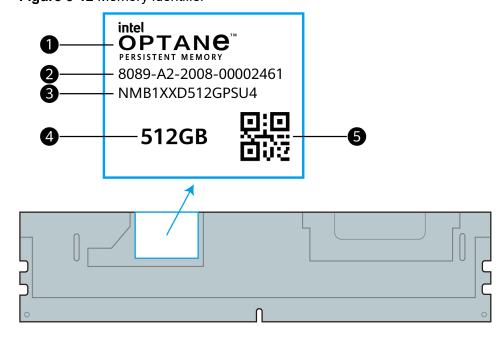
The following memory protection technologies are supported:

- ECC
- Memory Mirroring
- Memory Single Device Data Correction (SDDC)
- Failed DIMM Isolation
- Memory Thermal Throttling
- Command/Address Parity Check and Retry
- Memory Demand/Patrol Scrubbing
- Memory Data Scrambling
- Post Package Repair (PPR)
- Write Data CRC Protection
- Adaptive Data Correction Single Region (ADC-SR)
- Adaptive Double Device Data Correction Multiple Region (ADDDC-MR)
- Partial Cache Line Sparing (PCLS)

#### 5.4.2 PMem

### **5.4.2.1 Memory Identifier**

Figure 5-12 Memory identifier



| No. | Description | Example   |
|-----|-------------|---|
| 1   | Component   | Intel Optane <sup>TM</sup> Persistent<br>Memory |

| No. | Description   | Example                                       |
|-----|---------------|---|
| 2   | SN            | 8089-A2-2008-00002461                         |
| 3   | Model         | NMB1XXD512GPSU4                               |
| 4   | Capacity (GB) | <ul><li>128</li><li>256</li><li>512</li></ul> |
| 5   | SN QR code    | 8089-A2-2008-00002461                         |

# **5.4.2.2 Memory Subsystem Architecture**

The server provides 32 memory slots. Each processor integrates eight memory channels, and each memory channel supports only one PMem module.

PMem modules must be used with DDR4 memory modules.

Table 5-7 Memory channels

| CPU   | Channel     | Memory Slot |
|-------|-------------|-------------|
| CPU 1 | A (primary) | DIMM000(A)  |
|       | А           | DIMM001(I)  |
|       | B (primary) | DIMM010(B)  |
|       | В           | DIMM011(J)  |
|       | C (primary) | DIMM020(C)  |
|       | С           | DIMM021(K)  |
|       | D (primary) | DIMM030(D)  |
|       | D           | DIMM031(L)  |
|       | E (primary) | DIMM040(E)  |
|       | Е           | DIMM041(M)  |
|       | F (primary) | DIMM050(F)  |
|       | F           | DIMM051(N)  |
|       | G (primary) | DIMM060(G)  |
|       | G           | DIMM061(O)  |
|       | H (primary) | DIMM070(H)  |
|       | Н           | DIMM071(P)  |
| CPU2  | A (primary) | DIMM100(A)  |

| CPU | Channel     | Memory Slot |
|-----|-------------|-------------|
|     | A           | DIMM101(I)  |
|     | B (primary) | DIMM110(B)  |
|     | В           | DIMM111(J)  |
|     | C (primary) | DIMM120(C)  |
|     | С           | DIMM121(K)  |
|     | D (primary) | DIMM130(D)  |
|     | D           | DIMM131(L)  |
|     | E (primary) | DIMM140(E)  |
|     | Е           | DIMM141(M)  |
|     | F (primary) | DIMM150(F)  |
|     | F           | DIMM151(N)  |
|     | G (primary) | DIMM160(G)  |
|     | G           | DIMM161(O)  |
|     | H (primary) | DIMM170(H)  |
|     | Н           | DIMM171(P)  |

## 5.4.2.3 Memory Compatibility

Observe the following rules when configuring PMem modules:

### NOTICE

- The PMem modules must be used with the DDR4 memory modules. For details, see *PMem 200-Barlow pass User Guide*.
- For details about the optional components, consult the local sales representative or see "Search Parts" in the compatibility list on the technical support website.
- The memory must be used with the third-generation Intel<sup>®</sup> Xeon<sup>®</sup> Scalable Ice Lake processors. The maximum memory capacity supported by all processor models is the same.
- The PMem module can work only in App Direct Mode (AD) and Memory Mode (MM). The total supported memory capacity is calculated as follows:
  - PMem module in AD mode
     Total memory capacity = Total capacity of all PMem modules+ Total capacity of all DDR4 memory modules
  - PMem module in MM mode

Total memory capacity = Total capacity of all PMem modules (The DDR4 memory modules are used as the cache and therefore are not calculated as memory capacity.)

#### NOTICE

For details about the AD and MM modes, see *PMem 200-Barlow pass User Guide*.

- For details about the capacity type of a single memory module, see "Search Parts" in the compatibility list on the technical support website.
- The maximum number of memory modules supported depends on the memory type and rank quantity.

### **◯** NOTE

Each memory channel supports a maximum of 8 ranks. The number of memory modules supported by each channel varies depending on the number of ranks supported by each channel:

Number of memory modules supported by each channel ≤ Number of ranks supported by each memory channel/Number of ranks supported by each memory module

| Table 5-8 | PMem s | pecifications |
|-----------|--------|---------------|
|-----------|--------|---------------|

| Parameter   | Specifications |      |      |  |
|---|----------------|------|------|--|
| Capacity per PMem module (GB)                           | 128            | 256  | 512  |  |
| Rated speed (MT/s)                                      | 3200           | 3200 | 3200 |  |
| Operating voltage (V)                                   | 1.2            | 1.2  | 1.2  |  |
| Maximum number of PMem modules in a server <sup>a</sup> | 16             | 16   | 16   |  |
| Maximum PMem capacity of the server (GB) <sup>b</sup>   | 2048           | 4096 | 8192 |  |
| Actual rate (MT/s)                                      | 3200           | 3200 | 3200 |  |

- a: The maximum number of PMem modules is based on dual-processor configuration. The value is halved for a server with only one processor.
- b: The maximum PMem capacity varies depending on the PMem working mode.
- The information listed in this table is for reference only. For details, consult the local sales representative.

### 5.4.2.4 DIMM Installation Rules

Observe the following when configuring PMem modules:

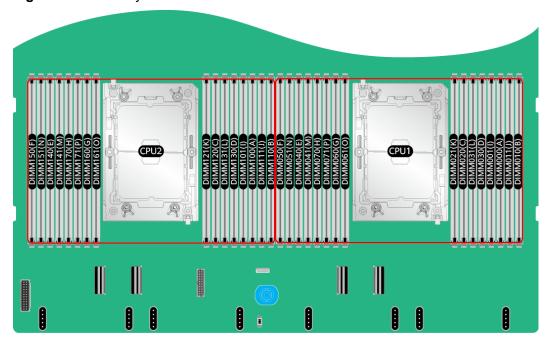
- The DDR4 memory modules used with the PMem modules include RDIMMs and LRDIMMs.
- The PMem modules used in a server must have the same P/N code.
- The DDR4 memory modules used with the PMem modules in a server must have the same P/N code.
- Observe the following when configuring PMem modules in MM mode:
   On the same server, it is recommended that the ratio of the DDR4 memory capacity to the PMem capacity be 1:4 to 1:16.

### **5.4.2.5 Memory Installation Positions**

A server supports a maximum of 16 PMem modules. The PMem modules must be used with the DDR4 memory modules.

Observe the memory module installation rules when configuring memory modules. For details, see the *Memory Configuration Guide* of the server on the technical support website.

Figure 5-13 Memory slots



**Installation Guideline** (●: DDR4 O: PMem) CPU Channel **DIMM Slot** AD MM ΑD AD MM AD MM AD ΑD 4+4 6+1 8+1 8+4 8+8 12+2 DIMM000(A) • • • Α DIMM001(I) 0 0 0 • IMC0 0 DIMM010(B) • • • • 0 В DIMM011(J) 0 DIMM020(C) • • • • C DIMM021(K) 0 0 • IMC1 DIMM030(D) • D DIMM031(L) 0 • CPU1 DIMM040(E) • Ε DIMM041(M) 0 0 • IMC2 DIMM050(F) F DIMM051(N) O DIMM060(G) DIMM061(O) 0 O IMC3 DIMM070(H) Н DIMM071(P) 0

Figure 5-14 PMem module installation guidelines (1 processor)

Figure 5-15 PMem module installation guidelines (2 processors)

| CPU Channel |        | DIMM Slot  | Installation Guideline<br>(●: DDR4 ○: PMem) |    |    |      |      |          |          |    |      |     |    |
|-------------|--------|------------|---|----|----|------|------|----------|----------|----|------|-----|----|
|             |        |            | AD  | MM | AD | AD   | AD   | MM       | AD       | MM | A    | D   |    |
|             |        |            |   | 8+ | 8  | 12+2 | 16+2 | 16       | +8       | 16 | 5+16 | 24- | +4 |
|             | A      |            | DIMM000(A)                                  | •  | )  | •    | •    |          | •        |    | •    | •   |    |
|             | IMC0   | A          | DIMM001(I)                                  |    |    |      | 0    |          | O C      |    | 0    | •   | •  |
|             | IIVICO | В          | DIMM010(B)                                  | C  | )  | •    | •    |          | •        |    | •    | C   | )  |
|             |        | Ь          | DIMM011(J)                                  |    |    |      |      |          |          |    | 0    |     |    |
|             |        | С          | DIMM020(C)                                  | •  |    | •    | •    |          | •        |    | •    | •   |    |
|             | IMC1   | C          | DIMM021(K)                                  |    |    |      |      |          | <b>)</b> |    | 0    | •   | •  |
|             | IIVICI | D          | DIMM030(D)                                  | C  | )  | 0    | •    |          | •        |    | •    | •   |    |
| CPU1        |        | D          | DIMM031(L)                                  |    |    |      |      |          |          |    | 0    | •   | •  |
| CPUI        |        | Е          | DIMM040(E)                                  | •  | )  | •    | •    |          | •        |    | •    | •   |    |
|             | IMC2   | _          | DIMM041(M)                                  |    |    |      |      |          | )        |    | 0    | •   | •  |
|             | IIVICZ | F          | DIMM050(F)                                  | C  | )  | •    | •    |          | •        |    | •    | C   | )  |
|             |        | г          | DIMM051(N)                                  |    |    |      |      |          |          |    | 0    |     |    |
|             |        | G          | DIMM060(G)                                  | •  | ,  | •    | •    |          | •        |    | •    | •   | •  |
|             | INACO  |            | DIMM061(O)                                  |    |    |      |      | (        | Э        |    | 0    | •   | •  |
|             | IMC3   | Н          | DIMM070(H)                                  | C  | )  |      | •    |          | •        |    | •    | •   | •  |
|             |        |            | DIMM071(P)                                  |    |    |      |      |          |          |    | 0    | •   | •  |
|             |        | А          | DIMM000(A)                                  | •  | ,  | •    | •    |          | •        |    | •    | •   | •  |
|             | IMC0   | A          | DIMM001(I)                                  |    |    |      | 0    | (        | Э        |    | 0    | •   | •  |
|             |        | В          | DIMM010(B)                                  | C  | )  | •    | •    |          | •        |    | •    | C   | )  |
|             |        | В          | DIMM011(J)                                  |    |    |      |      |          |          |    | 0    |     |    |
|             | С      | _          | DIMM020(C)                                  | •  | ,  | •    | •    |          | •        |    | •    | •   | •  |
|             |        | DIMM021(K) |   |    |    |      | (    | )        |          | 0  | •    | •   |    |
|             | IMC1   | D          | DIMM030(D)                                  | C  | )  | 0    | •    |          | •        |    | •    | •   | •  |
| CPU2        |        | D          | DIMM031(L)                                  |    |    |      |      |          |          |    | 0    | •   | •  |
| CPU2        |        | Е          | DIMM040(E)                                  | •  | ,  | •    | •    |          | •        |    | •    | •   | •  |
|             | E      | DIMM041(M) |   |    |    |      | (    | <b>)</b> |          | 0  | •    | •   |    |
|             | IMC2   | _          | DIMM050(F)                                  | C  | )  | •    | •    |          | •        |    | •    | C   | )  |
|             |        | F          | DIMM051(N)                                  |    |    |      |      |          |          |    | 0    |     |    |
|             |        | _          | DIMM060(G)                                  | •  | )  | •    | •    |          | •        |    | •    | •   | •  |
|             | 18463  | G          | DIMM061(O)                                  |    |    |      |      | (        | )        |    | 0    | •   | •  |
|             | IMC3   | - 11       | DIMM070(H)                                  | C  | )  |      | •    |          | •        |    | •    | •   | •  |
|             |        | Н          | DIMM071(P)                                  |    |    |      |      |          |          |    | 0    | •   | •  |

## **5.4.2.6 Memory Protection Technologies**

The following memory protection technologies are supported:

- PMem module Error Detection and Correction
- PMem module Device Failure Recovery (SDDC)
- PMem module Package Sparing (DDDC)
- PMem module Patrol Scrubbing
- PMem module Address Error Detection
- PMem module Data Poisoning (Corrupt Data Containment)
- PMem module Viral
- PMem module Address Range Scrub (ARS)
- PMem module Error Injection
- DDR-T Command and Address Parity Check and Retry
- DDR-T Read Write Data ECC Check and Retry
- PMem module Faulty DIMM Isolation
- PMem module Error Reporting

## 5.5 Storage

# **5.5.1 Drive Configurations**

Table 5-9 Drive configuration

| Configuratio<br>n           | Front Drive  | Rear Drive   | Built-in Drive | Drive<br>Management<br>Mode  |
|-----------------------------|--|--|----------------|--|
| Single-RAID configuration 1 | Front drive (24 x 3.5"):  Slots 0 to 23 support only SAS/ SATA drives. | <ul> <li>I/O module 1: 2 x 2.5"/2 x 3.5" <ul> <li>Slots 40</li> <li>and 41</li> <li>support only SAS/ SATA drives.</li> </ul> </li> <li>I/O module 2: 2 x 2.5"/2 x 3.5" <ul> <li>Slots 42</li> <li>and 43</li> <li>support only SAS/ SATA drives.</li> </ul> </li> <li>I/O module 3: 4 x 2.5" <ul> <li>Slots 44</li> <li>to 47</li> <li>support only NVMe drives<sup>a</sup>.</li> </ul> </li> <li>Rear drives (12 x 3.5"): <ul> <li>Rear slots 24</li> <li>to 35</li> <li>support only NVMe drives<sup>a</sup>.</li> </ul> </li> <li>Rear slots 24 to 35</li> <li>support only SAS/ SATA drives.</li> </ul> |                | <ul> <li>SAS/SATA drive: 1 x screw-in RAID controller card</li> <li>NVMe drive: CPU</li> </ul> |

| Configuratio<br>n           | Front Drive   | Rear Drive  | Built-in Drive | Drive<br>Management<br>Mode  |
|-----------------------------|---|---|----------------|--|
| Single-RAID configuration 2 | • Front drive (24 x 3.5"):  - Slots 0 to 23 support only SAS/SATA drives. | <ul> <li>I/O module         1: 2 x 2.5"         <ul> <li>Slots 40</li> <li>and 41</li> <li>support only</li> <li>SAS/</li> <li>SATA</li> <li>drives.</li> </ul> </li> <li>I/O module         2: 2 x         2.5"/2 x         3.5"         <ul> <li>Slots 42</li> <li>and 43</li> <li>support only</li> <li>SAS/</li> <li>SATA</li> <li>drives.</li> </ul> </li> <li>I/O module         3: 4 x 2.5"         <ul> <li>Slots 44</li> <li>to 47</li> <li>support only</li> <li>NVMe</li> <li>drives<sup>a</sup>.</li> </ul> </li> <li>Rear drives         (12 x 3.5"):         <ul> <li>Rear</li> <li>slots 24</li> <li>to 35</li> <li>support only</li> <li>SAS/</li> <li>SATA</li> <li>drives.</li> </ul> </li> </ul> |                | <ul> <li>SAS/SATA drive: 1 x PCle RAID controller card</li> <li>NVMe drive: CPU</li> </ul> |

| Configuratio<br>n           | Front Drive   | Rear Drive   | Built-in Drive   | Drive<br>Management<br>Mode |
|-----------------------------|---|--|--|-----------------------------|
| Single-RAID configuration 3 | • Front drive (24 x 3.5"):  - Slots 0 to 23 support only SAS/SATA drives. | <ul> <li>I/O module         1: 2 x         2.5"/2 x         3.5"         <ul> <li>Slots 40</li></ul></li></ul> | Built-in drive: 4 x 3.5"  Slots 36 to 39 support only SAS/SATA drives. |                             |
|                             |   | (12 x 3.5"):  - Rear slots 24 to 35 support only SAS/ SATA drives.   |  |                             |

| Configuratio<br>n           | Front Drive   | Rear Drive  | Built-in Drive   | Drive<br>Management<br>Mode  |
|-----------------------------|---|---|--|--|
| Single-RAID configuration 4 | Front drive (24 x 3.5"):  Slots 0 to 23 support only SAS/SATA drives. | <ul> <li>I/O module         1: 2 x 2.5"         <ul> <li>Slots 40</li> <li>and 41</li> <li>support only</li> <li>SAS/</li> <li>SATA</li> <li>drives.</li> </ul> </li> <li>I/O module         2: 2 x         2.5"/2 x         3.5"         <ul> <li>Slots 42</li> <li>and 43</li> <li>support only</li> <li>SAS/</li> <li>SATA</li> <li>drives.</li> </ul> </li> <li>I/O module         3: 4 x 2.5"         <ul> <li>Slots 44</li> <li>to 47</li> <li>support</li> <li>SAS/</li> <li>SATA/</li> <li>NVMe</li> <li>drives<sup>a</sup>.</li> </ul> </li> <li>Rear drives         <ul> <li>(12 x 3.5"):</li> <li>Rear</li> <li>slots 24</li> <li>to 35</li> <li>support</li> <li>only</li> <li>SAS/</li> <li>SATA</li> <li>drives.</li> </ul> </li> </ul> | Built-in drive: 4 x 3.5"  Slots 36 to 39 support only SAS/SATA drives. | <ul> <li>SAS/SATA drive: 1 x PCIe RAID controller card</li> <li>NVMe drive: CPU</li> </ul> |

| Configuratio<br>n         | Front Drive  | Rear Drive  | Built-in Drive | Drive<br>Management<br>Mode   |
|---------------------------|--|---|----------------|---|
| Dual-RAID configuration 1 | Front drive (24 x 3.5"):  Slots 0 to 23 support only SAS/ SATA drives. | I/O module 1: 2 x 2.5"  Slots 40 and 41 support only SAS/ SATA drives.  I/O module 2: 2 x 2.5"/2 x 3.5"  Slots 42 and 43 support only SAS/ SATA drives.  I/O module 3: 4 x 2.5"  Slots 44 to 47 support only NVMe drivesa  Rear drives (12 x 3.5"):  Rear slots 24 to 35 support only SAS/ SATA drives. |                | SAS/SATA drive: 1 x screw-in RAID controller card + 1 x PCIe RAID controller card.  One screw-in RAID controlle r card manage s the drives in slots 40 to 41.  One PCIe RAID controlle r card manage s the drives in slots 40 to 41.  NVMe drive: CPU |

| Configuratio<br>n         | Front Drive  | Rear Drive  | Built-in Drive   | Drive<br>Management<br>Mode   |
|---------------------------|--|---|--|---|
| Dual-RAID configuration 2 | Front drive (24 x 3.5"):  Slots 0 to 23 support only SAS/ SATA drives. | <ul> <li>I/O module 1: 2 x 2.5" <ul> <li>Slots 40</li></ul></li></ul> | Built-in drive: 4 x 3.5"  Slots 36 to 39 support only SAS/SATA drives. | SAS/SATA drive: 1 x screw-in RAID controller card + 1 x PCIe RAID controller card.  One screw-in RAID controlle r card manage s the drives in slots 40 to 41.  One PCIe RAID controlle r card manage s the drives in slots 40 to 41.  NVMe drive: CPU |

| Configuratio<br>n         | Front Drive  | Rear Drive  | Built-in Drive | Drive<br>Management<br>Mode   |
|---------------------------|--|---|----------------|---|
| Dual-RAID configuration 3 | Front drive (24 x 3.5"):  Slots 0 to 23 support only SAS/ SATA drives. | I/O module 1: 2 x 2.5"  Slots 40 and 41 support only SAS/ SATA drives.  I/O module 2: 2 x 2.5"/2 x 3.5"  Slots 42 and 43 support only SAS/ SATA drives.  I/O module 3: 4 x 2.5"  Slots 44 to 47 support only NVMe drivesa  Rear drives (12 x 3.5"):  Rear slots 24 to 35 support only SAS/ SATA drives. |                | SAS/SATA drive: 1 x screw-in RAID controller card + 1 x PCIe RAID controller card.  One screw-in RAID controlle r card manage s the drives in slots 0 to 23 and slots 40 to 43.  One PCIe RAID controlle r card manage s the drives in slots 24 to 35.  NVMe drive: CPU |

| Configuratio | Front Drive | Rear Drive | Built-in Drive | Drive      |
|--------------|-------------|------------|----------------|------------|
| n            |             |            |                | Management |
|              |             |            |                | Mode       |

- a: The server with CPU 2 supports NVMe drives, but the server with a single CPU does not support NVMe drives.
- The server with dual-RAID configuration 3 uses an EXP backplane connecting 12 x 3.5" drives. The server with other RAID configurations uses a pass-through backplane connecting 12 x 3.5" drives.
- Note: Contact your local sales representative or see "Search Parts" in the compatibility list on the technical support website to determine the components to be used.

## 5.5.2 Drive Numbering

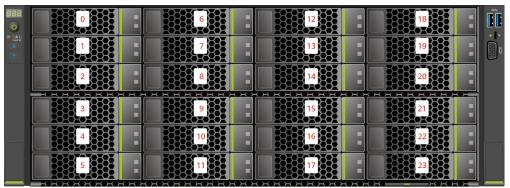
### **◯** NOTE

The drive numbers identified by the RAID controller card vary depending on the cabling of the RAID controller card. The drive numbers identified by the RAID controller card in this section are provided based on the default cabling described in "Internal Cabling" in the *Maintenance and Service Guide*.

Single-RAID configuration

For details, see single-RAID configuration 1 in **5.5.1 Drive Configurations**.

Figure 5-16 Drive slot numbers (3.5" drives in I/O module 1 and I/O module 2)



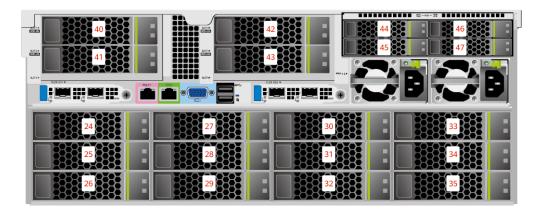
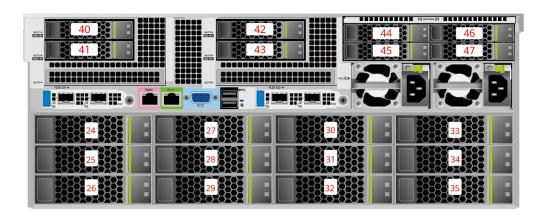
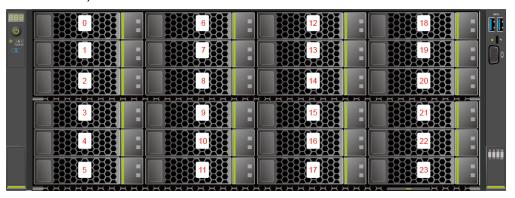
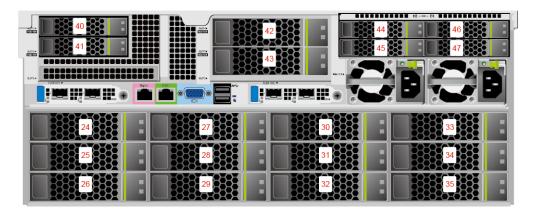


Figure 5-17 Drive slot numbers (2.5" drives in I/O module 1 and I/O module 2)



**Figure 5-18** Drive slot numbers (2.5" drives in I/O module 1 and 3.5" drives in I/O module 2)





**Figure 5-19** Drive slot numbers (3.5" drives in I/O module 1 and 2.5" drives in I/O module 2)





Table 5-10 Slot numbers

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 0         | 0                                      | 0  |
| 1         | 1                                      | 1  |
| 2         | 2                                      | 2  |
| 3         | 3                                      | 3  |
| 4         | 4                                      | 4  |
| 5         | 5                                      | 5  |
| 6         | 6                                      | 6  |
| 7         | 7                                      | 7  |
| 8         | 8                                      | 8  |
| 9         | 9                                      | 9  |
| 10        | 10                                     | 10   |
| 11        | 11                                     | 11   |

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 12        | 12                                     | 12   |
| 13        | 13                                     | 13   |
| 14        | 14                                     | 14   |
| 15        | 15                                     | 15   |
| 16        | 16                                     | 16   |
| 17        | 17                                     | 17   |
| 18        | 18                                     | 18   |
| 19        | 19                                     | 19   |
| 20        | 20                                     | 20   |
| 21        | 21                                     | 21   |
| 22        | 22                                     | 22   |
| 23        | 23                                     | 23   |
| 24        | 24                                     | 24   |
| 25        | 25                                     | 25   |
| 26        | 26                                     | 26   |
| 27        | 27                                     | 27   |
| 28        | 28                                     | 28   |
| 29        | 29                                     | 29   |
| 30        | 30                                     | 30   |
| 31        | 31                                     | 31   |
| 32        | 32                                     | 32   |
| 33        | 33                                     | 33   |
| 34        | 34                                     | 34   |
| 35        | 35                                     | 35   |
| 40        | 40                                     | 36   |
| 41        | 41                                     | 37   |
| 42        | 42                                     | 38   |
| 43        | 43                                     | 39   |
| 44        | 44                                     | -  |

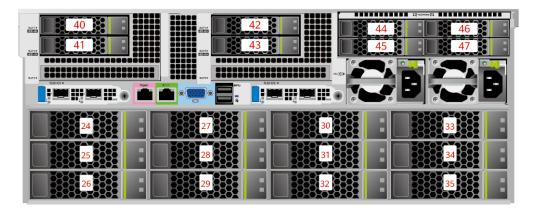
| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 45        | 45                                     | -  |
| 46        | 46                                     | -  |
| 47        | 47                                     | -  |

### Single-RAID configuration

For details, see single-RAID configuration 2 in **5.5.1 Drive Configurations**.

Figure 5-20 Drive slot numbers (2.5" drives in I/O module 1 and I/O module 2)





**Figure 5-21** Drive slot numbers (2.5" drives in I/O module 1 and 3.5" drives in I/O module 2)



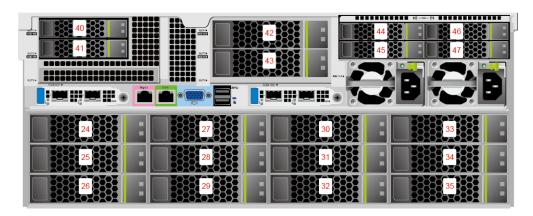


Table 5-11 Slot numbers

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 0         | 0                                      | 0  |
| 1         | 1                                      | 1  |
| 2         | 2                                      | 2  |
| 3         | 3                                      | 3  |
| 4         | 4                                      | 4  |
| 5         | 5                                      | 5  |
| 6         | 6                                      | 6  |
| 7         | 7                                      | 7  |
| 8         | 8                                      | 8  |
| 9         | 9                                      | 9  |
| 10        | 10                                     | 10   |
| 11        | 11                                     | 11   |

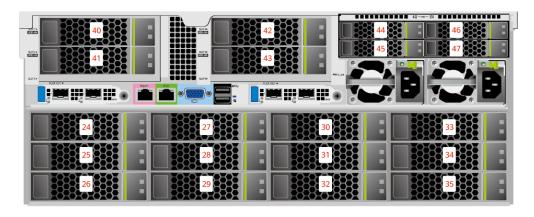
| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 12        | 12                                     | 12   |
| 13        | 13                                     | 13   |
| 14        | 14                                     | 14   |
| 15        | 15                                     | 15   |
| 16        | 16                                     | 16   |
| 17        | 17                                     | 17   |
| 18        | 18                                     | 18   |
| 19        | 19                                     | 19   |
| 20        | 20                                     | 20   |
| 21        | 21                                     | 21   |
| 22        | 22                                     | 22   |
| 23        | 23                                     | 23   |
| 24        | 24                                     | 24   |
| 25        | 25                                     | 25   |
| 26        | 26                                     | 26   |
| 27        | 27                                     | 27   |
| 28        | 28                                     | 28   |
| 29        | 29                                     | 29   |
| 30        | 30                                     | 30   |
| 31        | 31                                     | 31   |
| 32        | 32                                     | 32   |
| 33        | 33                                     | 33   |
| 34        | 34                                     | 34   |
| 35        | 35                                     | 35   |
| 40        | 40                                     | 36   |
| 41        | 41                                     | 37   |
| 42        | 42                                     | 38   |
| 43        | 43                                     | 39   |
| 44        | 44                                     | -  |

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 45        | 45                                     | -  |
| 46        | 46                                     | -  |
| 47        | 47                                     | -  |

## • Single-RAID configuration

For details, see single-RAID configuration 3 in **5.5.1 Drive Configurations**.

Figure 5-22 Drive slot numbers (3.5" drives in I/O module 1 and I/O module 2)



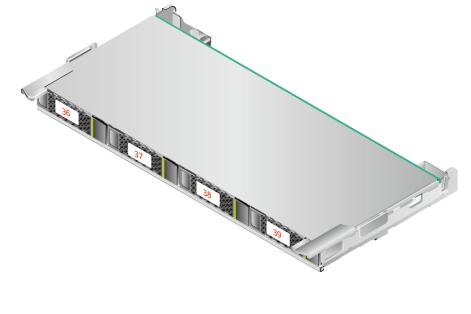


Figure 5-23 Drive slot numbers (2.5" drives in I/O module 1 and 3.5" drives in I/O module 2)





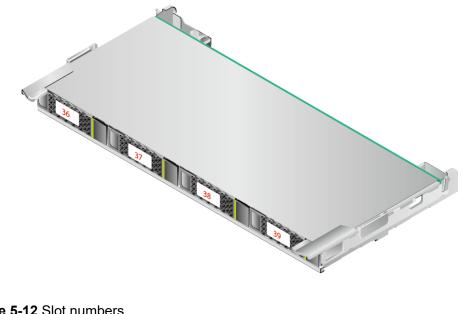


Table 5-12 Slot numbers

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 0         | 0                                      | 0  |
| 1         | 1                                      | 1  |

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 2         | 2                                      | 2  |
| 3         | 3                                      | 3  |
| 4         | 4                                      | 4  |
| 5         | 5                                      | 5  |
| 6         | 6                                      | 6  |
| 7         | 7                                      | 7  |
| 8         | 8                                      | 8  |
| 9         | 9                                      | 9  |
| 10        | 10                                     | 10   |
| 11        | 11                                     | 11   |
| 12        | 12                                     | 12   |
| 13        | 13                                     | 13   |
| 14        | 14                                     | 14   |
| 15        | 15                                     | 15   |
| 16        | 16                                     | 16   |
| 17        | 17                                     | 17   |
| 18        | 18                                     | 18   |
| 19        | 19                                     | 19   |
| 20        | 20                                     | 20   |
| 21        | 21                                     | 21   |
| 22        | 22                                     | 22   |
| 23        | 23                                     | 23   |
| 24        | 24                                     | 24   |
| 25        | 25                                     | 25   |
| 26        | 26                                     | 26   |
| 27        | 27                                     | 27   |
| 28        | 28                                     | 28   |
| 29        | 29                                     | 29   |
| 30        | 30                                     | 30   |

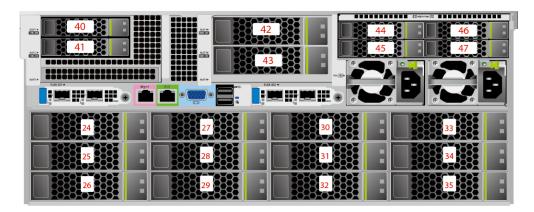
| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 31        | 31                                     | 31   |
| 32        | 32                                     | 32   |
| 33        | 33                                     | 33   |
| 34        | 34                                     | 34   |
| 35        | 35                                     | 35   |
| 36        | 36                                     | 8  |
| 37        | 37                                     | 9  |
| 38        | 38                                     | 10   |
| 39        | 39                                     | 11   |
| 40        | 40                                     | 36   |
| 41        | 41                                     | 37   |
| 42        | 42                                     | 38   |
| 43        | 43                                     | 39   |
| 44        | 44                                     | 12 <sup>Note</sup>                                   |
| 45        | 45                                     | 13 <sup>Note</sup>                                   |
| 46        | 46                                     | 14 <sup>Note</sup>                                   |
| 47        | 47                                     | 15 <sup>Note</sup>                                   |

- Note: If the slot is configured with a SAS/SATA drive, the RAID controller card can manage the drive and allocate a number to the drive.
- If duplicate RAID controller card numbers are displayed, identify the RAID controller cards based on the EID.
- Single-RAID configuration

For details, see single-RAID configuration 4 in **5.5.1 Drive Configurations**.

**Figure 5-24** Drive slot numbers (2.5" drives in I/O module 1 and 3.5" drives in I/O module 2)





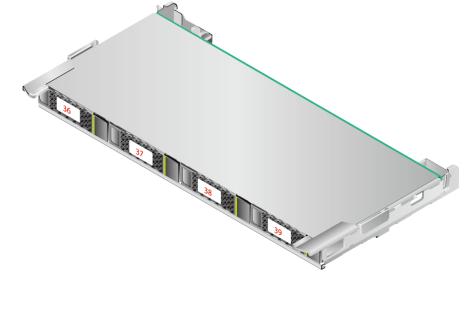
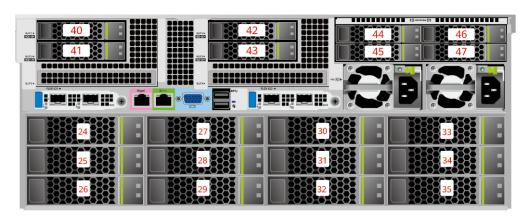


Figure 5-25 Drive slot numbers (2.5" drives in I/O module 1 and I/O module 2)



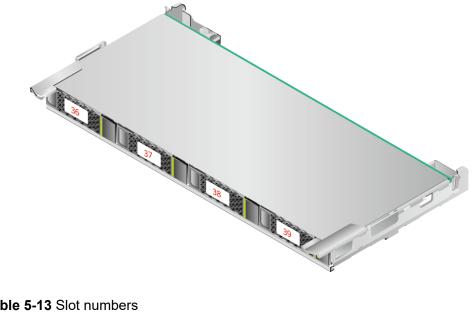


Table 5-13 Slot numbers

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 0         | 0                                      | 0  |
| 1         | 1                                      | 1  |

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 2         | 2                                      | 2  |
| 3         | 3                                      | 3  |
| 4         | 4                                      | 4  |
| 5         | 5                                      | 5  |
| 6         | 6                                      | 6  |
| 7         | 7                                      | 7  |
| 8         | 8                                      | 8  |
| 9         | 9                                      | 9  |
| 10        | 10                                     | 10   |
| 11        | 11                                     | 11   |
| 12        | 12                                     | 12   |
| 13        | 13                                     | 13   |
| 14        | 14                                     | 14   |
| 15        | 15                                     | 15   |
| 16        | 16                                     | 16   |
| 17        | 17                                     | 17   |
| 18        | 18                                     | 18   |
| 19        | 19                                     | 19   |
| 20        | 20                                     | 20   |
| 21        | 21                                     | 21   |
| 22        | 22                                     | 22   |
| 23        | 23                                     | 23   |
| 24        | 24                                     | 24   |
| 25        | 25                                     | 25   |
| 26        | 26                                     | 26   |
| 27        | 27                                     | 27   |
| 28        | 28                                     | 28   |
| 29        | 29                                     | 29   |
| 30        | 30                                     | 30   |

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 31        | 31                                     | 31   |
| 32        | 32                                     | 32   |
| 33        | 33                                     | 33   |
| 34        | 34                                     | 34   |
| 35        | 35                                     | 35   |
| 36        | 36                                     | 8  |
| 37        | 37                                     | 9  |
| 38        | 38                                     | 10   |
| 39        | 39                                     | 11   |
| 40        | 40                                     | 36   |
| 41        | 41                                     | 37   |
| 42        | 42                                     | 38   |
| 43        | 43                                     | 39   |
| 44        | 44                                     | 12 <sup>Note</sup>                                   |
| 45        | 45                                     | 13 <sup>Note</sup>                                   |
| 46        | 46                                     | 14 <sup>Note</sup>                                   |
| 47        | 47                                     | 15 <sup>Note</sup>                                   |

- Note: If the slot is configured with a SAS/SATA drive, the RAID controller card can manage the drive and allocate a number to the drive.
- If duplicate RAID controller card numbers are displayed, identify the RAID controller cards based on the EID.

### • Dual-RAID configuration

For details, see dual-RAID configuration 1 in 5.5.1 Drive Configurations.

**Figure 5-26** Drive slot numbers (2.5" drives in I/O module 1 and 3.5" drives in I/O module 2)

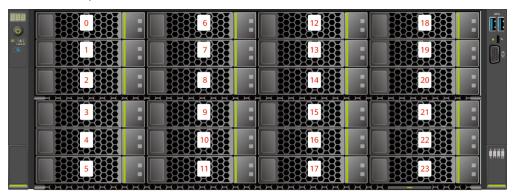
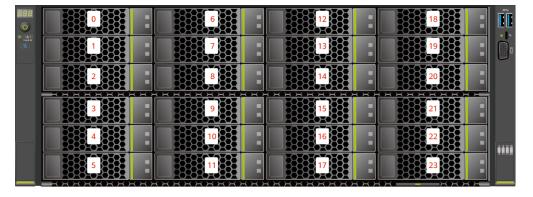




Figure 5-27 Drive slot numbers (2.5" drives in I/O module 1 and I/O module 2)



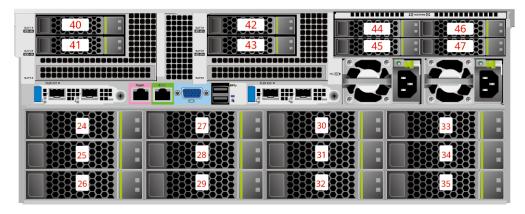


Table 5-14 Slot numbers

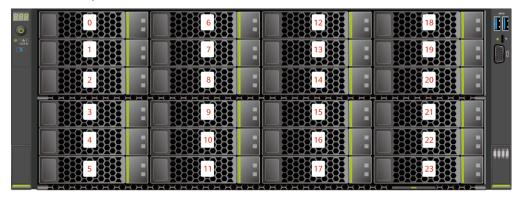
| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 0         | 0                                      | 0  |
| 1         | 1                                      | 1  |
| 2         | 2                                      | 2  |
| 3         | 3                                      | 3  |
| 4         | 4                                      | 4  |
| 5         | 5                                      | 5  |
| 6         | 6                                      | 6  |
| 7         | 7                                      | 7  |
| 8         | 8                                      | 8  |
| 9         | 9                                      | 9  |
| 10        | 10                                     | 10   |
| 11        | 11                                     | 11   |
| 12        | 12                                     | 12   |
| 13        | 13                                     | 13   |
| 14        | 14                                     | 14   |
| 15        | 15                                     | 15   |
| 16        | 16                                     | 16   |
| 17        | 17                                     | 17   |
| 18        | 18                                     | 18   |
| 19        | 19                                     | 19   |
| 20        | 20                                     | 20   |
| 21        | 21                                     | 21   |
| 22        | 22                                     | 22   |
| 23        | 23                                     | 23   |
| 24        | 24                                     | 24   |
| 25        | 25                                     | 25   |
| 26        | 26                                     | 26   |
| 27        | 27                                     | 27   |

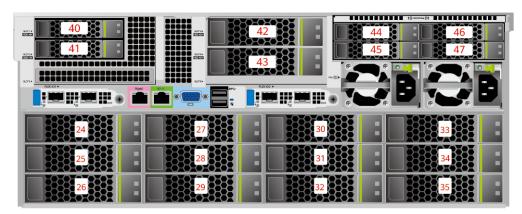
| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 28        | 28                                     | 28   |
| 29        | 29                                     | 29   |
| 30        | 30                                     | 30   |
| 31        | 31                                     | 31   |
| 32        | 32                                     | 32   |
| 33        | 33                                     | 33   |
| 34        | 34                                     | 34   |
| 35        | 35                                     | 35   |
| 40        | 40                                     | 0  |
| 41        | 41                                     | 1  |
| 42        | 42                                     | 36   |
| 43        | 43                                     | 37   |
| 44        | 44                                     | -  |
| 45        | 45                                     | -  |
| 46        | 46                                     | -  |
| 47        | 47                                     | -  |

## Dual-RAID configuration

For details, see dual-RAID configuration 2 in **5.5.1 Drive Configurations**.

**Figure 5-28** Drive slot numbers (2.5" drives in I/O module 1 and 3.5" drives in I/O module 2)





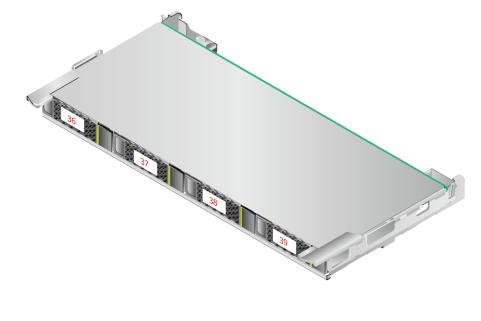
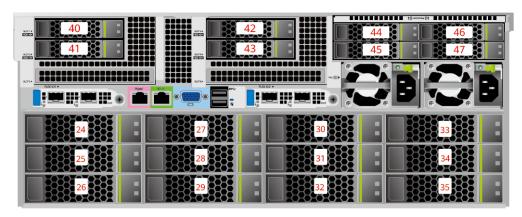


Figure 5-29 Drive slot numbers (2.5" drives in I/O module 1 and I/O module 2)



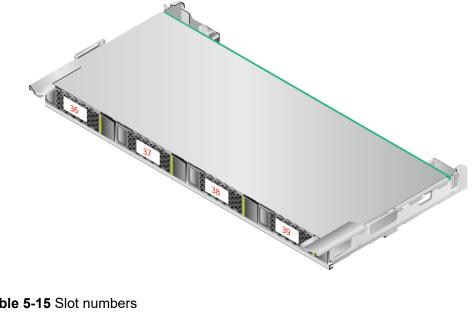


Table 5-15 Slot numbers

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 0         | 0                                      | 0  |
| 1         | 1                                      | 1  |

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 2         | 2                                      | 2  |
| 3         | 3                                      | 3  |
| 4         | 4                                      | 4  |
| 5         | 5                                      | 5  |
| 6         | 6                                      | 6  |
| 7         | 7                                      | 7  |
| 8         | 8                                      | 8  |
| 9         | 9                                      | 9  |
| 10        | 10                                     | 10   |
| 11        | 11                                     | 11   |
| 12        | 12                                     | 12   |
| 13        | 13                                     | 13   |
| 14        | 14                                     | 14   |
| 15        | 15                                     | 15   |
| 16        | 16                                     | 16   |
| 17        | 17                                     | 17   |
| 18        | 18                                     | 18   |
| 19        | 19                                     | 19   |
| 20        | 20                                     | 20   |
| 21        | 21                                     | 21   |
| 22        | 22                                     | 22   |
| 23        | 23                                     | 23   |
| 24        | 24                                     | 24   |
| 25        | 25                                     | 25   |
| 26        | 26                                     | 26   |
| 27        | 27                                     | 27   |
| 28        | 28                                     | 28   |
| 29        | 29                                     | 29   |
| 30        | 30                                     | 30   |

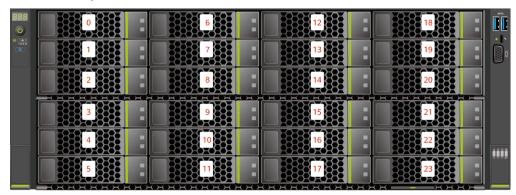
| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 31        | 31                                     | 31   |
| 32        | 32                                     | 32   |
| 33        | 33                                     | 33   |
| 34        | 34                                     | 34   |
| 35        | 35                                     | 35   |
| 36        | 36                                     | 8  |
| 37        | 37                                     | 9  |
| 38        | 38                                     | 10   |
| 39        | 39                                     | 11   |
| 40        | 40                                     | 0  |
| 41        | 41                                     | 1  |
| 42        | 42                                     | 36   |
| 43        | 43                                     | 37   |
| 44        | 44                                     | 12 <sup>Note</sup>                                   |
| 45        | 45                                     | 13 <sup>Note</sup>                                   |
| 46        | 46                                     | 14 <sup>Note</sup>                                   |
| 47        | 47                                     | 15 <sup>Note</sup>                                   |

- Note: If the slot is configured with a SAS/SATA drive, the RAID controller card can manage the drive and allocate a number to the drive.
- If duplicate RAID controller card numbers are displayed, identify the RAID controller cards based on the EID.

### Dual-RAID configuration

For details, see dual-RAID configuration 3 in 5.5.1 Drive Configurations.

**Figure 5-30** Drive slot numbers (2.5" drives in I/O module 1 and 3.5" drives in I/O module 2)



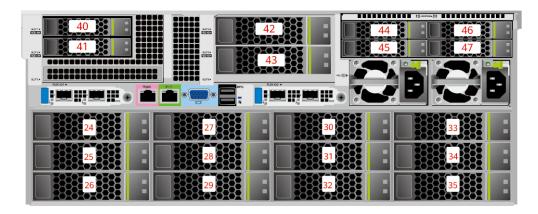


Figure 5-31 Drive slot numbers (2.5" drives in I/O module 1 and I/O module 2)





Table 5-16 Slot numbers

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 0         | 0                                      | 0  |
| 1         | 1                                      | 1  |
| 2         | 2                                      | 2  |
| 3         | 3                                      | 3  |
| 4         | 4                                      | 4  |
| 5         | 5                                      | 5  |
| 6         | 6                                      | 6  |
| 7         | 7                                      | 7  |
| 8         | 8                                      | 8  |
| 9         | 9                                      | 9  |
| 10        | 10                                     | 10   |
| 11        | 11                                     | 11   |
| 12        | 12                                     | 12   |
| 13        | 13                                     | 13   |
| 14        | 14                                     | 14   |
| 15        | 15                                     | 15   |
| 16        | 16                                     | 16   |
| 17        | 17                                     | 17   |
| 18        | 18                                     | 18   |
| 19        | 19                                     | 19   |
| 20        | 20                                     | 20   |
| 21        | 21                                     | 21   |
| 22        | 22                                     | 22   |
| 23        | 23                                     | 23   |
| 24        | 24                                     | 0  |
| 25        | 25                                     | 1  |
| 26        | 26                                     | 2  |
| 27        | 27                                     | 3  |

| Drive No. | Drive Number<br>Identified by the iBMC | Drive Number<br>Identified by the RAID<br>Controller |
|-----------|--|--|
| 28        | 28                                     | 4  |
| 29        | 29                                     | 5  |
| 30        | 30                                     | 6  |
| 31        | 31                                     | 7  |
| 32        | 32                                     | 8  |
| 33        | 33                                     | 9  |
| 34        | 34                                     | 10   |
| 35        | 35                                     | 11   |
| 40        | 40                                     | 36   |
| 41        | 41                                     | 37   |
| 42        | 42                                     | 38   |
| 43        | 43                                     | 39   |
| 44        | 44                                     | -  |
| 45        | 45                                     | -  |
| 46        | 46                                     | -  |
| 47        | 47                                     | -  |

## 5.5.3 Drive Indicators

## **SAS/SATA Drive Indicators**

Figure 5-32 SAS/SATA drive indicators

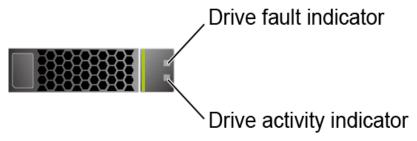
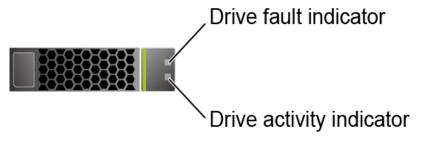


Table 5-17 SAS/SATA drive indicators

| Activity Indicator (Green) | Fault Indicator<br>(Yellow) | Description  |
|----------------------------|-----------------------------|--|
| Off                        | Off                         | The drive is not in position.  |
| Steady on                  | Off                         | The drive is detected.   |
| Blinking at 4 Hz           | Off                         | Data is being read or written properly, or data on the primary drive is being rebuilt. |
| Steady on                  | Blinking at 1 Hz            | The drive is being located.  |
| Blinking at 1 Hz           | Blinking at 1 Hz            | Data on the secondary drive is being rebuilt.  |
| Off                        | Steady on                   | A drive in a RAID array is removed.  |
| Steady on                  | Steady on                   | The drive is faulty.   |

#### **NVMe Drive Indicators**

Figure 5-33 NVMe drive indicators



 If the VMD function is enabled and the latest VMD driver is installed, the NVMe drives support surprise hot swap.

**Table 5-18** NVMe drive indicators (VMD enabled)

| Activity<br>Indicator<br>(Green) | Fault Indicator<br>(Yellow) | Description   |
|----------------------------------|-----------------------------|---|
| Off                              | Off                         | The NVMe drive is not detected.                       |
| Steady on                        | Off                         | The NVMe drive is detected and operating properly.    |
| Blinking at 2 Hz                 | Off                         | Data is being read from or written to the NVMe drive. |
| Steady on                        | Blinking at 2 Hz            | The NVMe drive is being located.                      |

| Activity<br>Indicator<br>(Green) | Fault Indicator<br>(Yellow) | Description  |
|----------------------------------|-----------------------------|--|
| Off                              | Blinking at 8 Hz            | The data on the secondary NVMe drive is being rebuilt. |
| Steady on/Off                    | Steady on                   | The NVMe drive is faulty.                              |

• If the VMD function is disabled, NVMe drives support only orderly hot swap.

Table 5-19 NVMe drive indicators (VMD disabled)

| Activity<br>Indicator<br>(Green) | Fault Indicator<br>(Yellow) | Description   |
|----------------------------------|-----------------------------|---|
| Off                              | Off                         | The NVMe drive is not detected.                                     |
| Steady on                        | Off                         | The NVMe drive is detected and operating properly.                  |
| Blinking at 2 Hz                 | Off                         | Data is being read from or written to the NVMe drive.               |
| Off                              | Blinking at 2 Hz            | The NVMe drive is being located or hot-swapped.                     |
| Off                              | Blinking at 0.5 Hz          | The NVMe drive has completed the hot swap process and is removable. |
| Steady on/Off                    | Steady on                   | The NVMe drive is faulty.   |

#### M.2 FRU Indicators

The server supports the Avago SAS3004iMR RAID controller card, which supports two M.2 FRUs.

Figure 5-34 M.2 FRU indicators

M.2 FRU fault indicator

M.2 FRU activity indicator

Table 5-20 M.2 FRU indicators

| M.2 FRU Active<br>Indicator (Green or<br>Light Green) | M.2 FRU Fault<br>Indicator (Yellow) | Description  |
|---|-------------------------------------|--|
| Off   | Off                                 | The M.2 FRU is not detected.                               |
| Steady on   | Off                                 | The M.2 FRU is inactive.                                   |
| Blink   | Off                                 | The M.2 FRU is in the read/write or synchronization state. |
| Steady on   | Blink                               | The M.2 FRU is being located.                              |
| Blink   | Blink                               | The RAID array is being rebuilt.                           |
| Off   | Steady on                           | The M.2 FRU cannot be detected or is faulty.               |
| Steady on   | Steady on                           | The M.2 FRU RAID status is abnormal.                       |

## 5.5.4 RAID Controller Card

The RAID controller card supports RAID configuration, RAID level migration, and drive roaming.

- For details about the optional components, consult the local sales representative or see "Search Parts" in the compatibility list on the technical support website.
- For details about the RAID controller card, see server RAID Controller Card User Guide.

## 5.6 Network

## 5.6.1 OCP 3.0 Network Adapter

OCP 3.0 network adapters provide network expansion capabilities.

- The FlexIO slot supports the OCP 3.0 network adapter, which can be configured as required.
- For details about the optional components, consult the local sales representative or see "Search Parts" in the compatibility list on the technical support website.
- For details about OCP 3.0 NICs, see OCP 3.0 NIC User Guide.

# 5.7 I/O Expansion

## 5.7.1 PCIe Cards

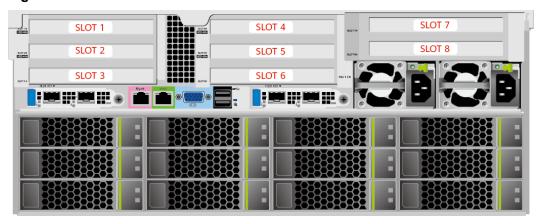
PCIe cards provide ease of expandability and connection.

- A maximum of eight PCle 4.0 slots are supported.
- For details about the optional components, consult the local sales representative or see "Search Parts" in the compatibility list on the technical support website.
- When IB cards are used to build an IB network, ensure that the IPoIB modes of the IB cards at both ends of the network are the same. For details, contact technical support.

#### 5.7.2 PCIe Slots

#### **PCIe Slots**

Figure 5-35 PCIe slots



- I/O module 1 provides slots 1, 2, and 3. If a two-slot PCle riser module is used, slot 1 is unavailable. If a module with 2 x 2.5" drives and one PCle card is used, slots 1 and 2 are unavailable.
- I/O module 2 provides slots 4, 5, and 6. If a two-slot PCle riser module is used, slot 4 is unavailable. If a module with 2 x 2.5" drives and one PCle card is used, slots 4 and 5 are unavailable.
- I/O module 3 provides slots 7 and 8. If a one-slot PCle riser module is used, slot 7 is unavailable.

#### **NOTE**

Observe the following rules when configuring GPU cards:

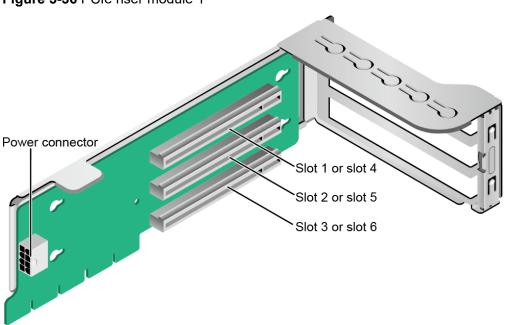
- When one to five x16 T4 GPU cards are configured:
  - I/O module 1 supports two HHHL PCIe x16 GPU cards.
  - I/O module 2 supports two HHHL PCle x16 GPU cards.
  - I/O module 3 supports one HHHL PCIe x16 GPU card (in slot 8).
- When six to eight T4 GPU cards (six x8 + two x16) are configured:
  - I/O module 1 supports two HHHL PCIe x8 and one HHHL x16 GPU cards.
  - I/O module 2 supports two HHHL PCIe x8 and one HHHL x16 GPU cards.
  - I/O module 3 supports two HHHL PCIe x8 GPU card.

## **PCIe Riser Modules**

PCle riser module 1 (universal)

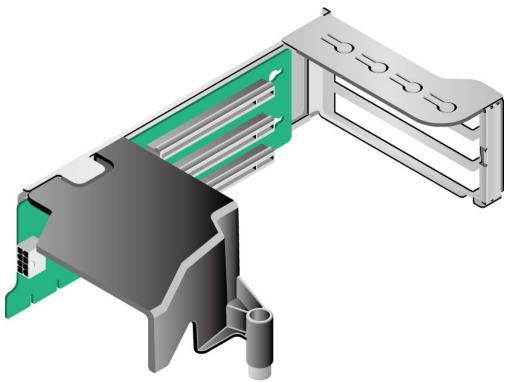
- It provides PCle slots 1, 2, and 3 when being installed in I/O module 1.
- It provides PCle slots 4, 5, and 6 when being installed in I/O module 2.

Figure 5-36 PCIe riser module 1



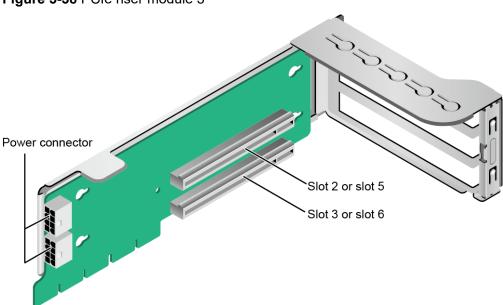
- PCIe riser module 2 (for T4 GPU cards only)
  - It provides PCIe slots 1, 2, and 3 when being installed in I/O module 1.
  - It provides PCIe slots 4, 5, and 6 when being installed in I/O module 2.

Figure 5-37 PCIe riser module 2



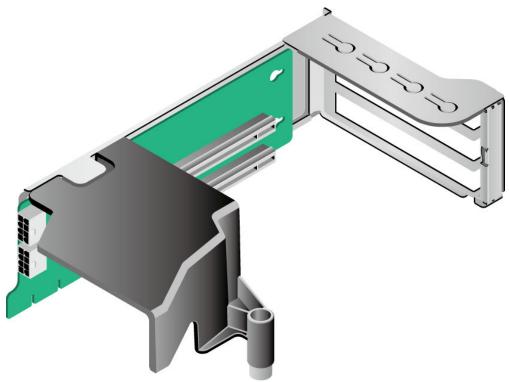
- PCle riser module 3 (universal)
  - Provides PCle slots 2 and 3 when installed in I/O module 1.
  - Provides PCle slots 5 and 6 when installed in I/O module 2.

Figure 5-38 PCle riser module 3



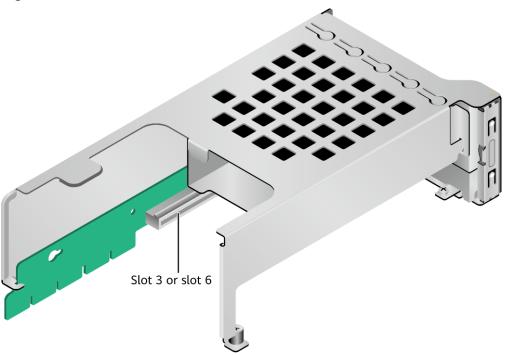
- PCIe riser module 4 (for T4 GPU cards only)
  - Provides PCle slots 2 and 3 when installed in I/O module 1.
  - Provides PCIe slots 5 and 6 when installed in I/O module 2.

Figure 5-39 PCle riser module 4



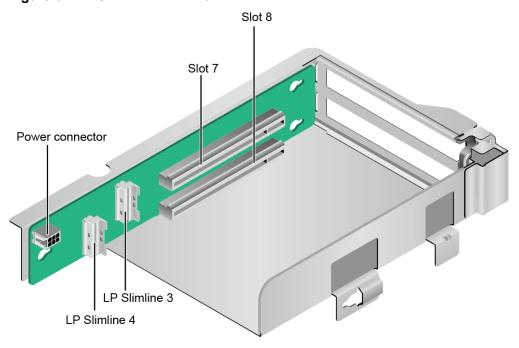
- 2 x 2.5" drives + PCle riser module
  - Provides PCle slot 3 when installed in I/O module 1.
  - Provides PCIe slot 6 when installed in I/O module 2.

Figure 5-40 2 x 2.5" drives + PCle riser module



PCIe riser module 6
 It provides PCIe slots 7 and 8 when being installed in I/O module 3.

Figure 5-41 PCle riser module 6



• PCle riser module 7

Provides PCIe slot 8 when installed in I/O module 3.

Power connector

LP Slimline 3

Figure 5-42 PCle riser module 7

# **5.7.3 PCIe Slot Description**

#### **◯** NOTE

The PCIe slots mapping to a vacant CPU socket are unavailable.

Table 5-21 PCle slot description

LP Slimline 4

| PCIe<br>Slot                                   | CPU   | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width | Port<br>No. | Root<br>Port<br>(B/D/F<br>) | Devic<br>e<br>(B/D/F<br>) | Slot<br>Size |
|--|-------|-----------------------|------------------------|--------------|-------------|-----------------------------|---------------------------|--------------|
| Screw-<br>in<br>RAID<br>control<br>ler<br>card | CPU 1 | PCIe<br>4.0           | x8                     | x8           | Port0A      | 16/02/<br>0                 | 17/00/<br>0               | 1            |

| PCle<br>Slot     | CPU   | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width  | Port<br>No. | Root<br>Port<br>(B/D/F<br>) | Devic<br>e<br>(B/D/F<br>) | Slot<br>Size                     |
|------------------|-------|-----------------------|------------------------|---|-------------|-----------------------------|---------------------------|----------------------------------|
| FlexIO<br>card 1 | CPU 1 | PCIe<br>4.0           | x16                    | x8 Expan sion cables used by the mainb oard: x8 + x8a | Port0C      | 16/04/<br>0                 | 18/00/<br>0               | OCP<br>3.0<br>specifi<br>cations |
| FlexIO<br>card 2 | CPU 2 | PCIe<br>4.0           | x16                    | x8 Expan sion cable used by the mainb oard: x16       | Port2A      | C9/02/<br>0                 | CA/<br>00/0               | OCP<br>3.0<br>specifi<br>cations |

| PCIe<br>Slot | CPU   | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width   | Port<br>No. | Root<br>Port<br>(B/D/F | Devic<br>e<br>(B/D/F<br>) | Slot<br>Size |
|--------------|-------|-----------------------|------------------------|--|-------------|------------------------|---------------------------|--------------|
| Slot1        | CPU 1 | PCIe<br>4.0           | x16                    | • 3-slot PCI e rise r mo dul e (PR M): x16 • 2-slot PR N/A • Mo dul e with 2 x 2.5" driv es and one PCI e car d: N/A | Port1A      | 30/02/                 | 31/00/                    | FHFL         |

| PCIe<br>Slot | CPU   | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width   | Port<br>No. | Root<br>Port<br>(B/D/F | Devic<br>e<br>(B/D/F | Slot<br>Size |
|--------------|-------|-----------------------|------------------------|--|-------------|------------------------|----------------------|--------------|
| Slot2        | CPU 1 | PCIe<br>4.0           | x16                    | • 3- slot PR M: x8 • 2- slot PR M: x16 • Mo dul e with 2 x 2.5" driv es and one PCI e car d: N/A | Port2A      | 4A/<br>02/0            | 4B/<br>00/0          | FHFL         |

| PCIe<br>Slot | CPU   | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width   | Port<br>No. | Root<br>Port<br>(B/D/F | Devic<br>e<br>(B/D/F | Slot<br>Size |
|--------------|-------|-----------------------|------------------------|--|-------------|------------------------|----------------------|--------------|
| Slot3        | CPU 1 | PCIe<br>4.0           | x16                    | • 3- slot PR M: x8 • 2- slot PR M: x16 • Mo dul e with 2 x 2.5" driv es and one PCI e car d: x16 | Port2C      | 4A/<br>04/0            | 4C/<br>00/0          | FHHL         |

| PCIe<br>Slot | CPU   | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width  | Port<br>No. | Root<br>Port<br>(B/D/F | Devic<br>e<br>(B/D/F<br>) | Slot<br>Size |
|--------------|-------|-----------------------|------------------------|---|-------------|------------------------|---------------------------|--------------|
| Slot4        | CPU 2 | PCIe<br>4.0           | x16                    | • 3- slot PR M: x16 • 2- slot PR M: N/A • Mo dul e with 2 x 2.5" driv es and one PCI e car d: N/A | Port0A      | 97/02/                 | 98/00/                    | FHFL         |

| PCIe<br>Slot | CPU   | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width   | Port<br>No. | Root<br>Port<br>(B/D/F | Devic<br>e<br>(B/D/F | Slot<br>Size |
|--------------|-------|-----------------------|------------------------|--|-------------|------------------------|----------------------|--------------|
| Slot5        | CPU 2 | PCIe<br>4.0           | x16                    | • 3- slot PR M: x8 • 2- slot PR M: x16 • Mo dul e with 2 x 2.5" driv es and one PCI e car d: N/A | Port1A      | B0/02/<br>0            | B1/00/<br>0          | FHFL         |

| PCIe<br>Slot | CPU   | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width   | Port<br>No. | Root<br>Port<br>(B/D/F | Devic<br>e<br>(B/D/F | Slot<br>Size |
|--------------|-------|-----------------------|------------------------|--|-------------|------------------------|----------------------|--------------|
| Slot6        | CPU 2 | PCIe<br>4.0           | x16                    | • 3- slot PR M: x8 • 2- slot PR M: x16 • Mo dul e with 2 x 2.5" driv es and one PCI e car d: x16 | Port1C      | B0/04/<br>0            | B2/00/<br>0          | FHHL         |
| Slot7        | CPU 2 | PCIe<br>4.0           | x16                    | • 2- slot PR M: x8 • 1- slot PR M: N/A   | Port3A      | E2/02/<br>0            | E3/00/<br>0          | FHHL         |
| Slot8        | CPU 2 | PCIe<br>4.0           | x16                    | • 2- slot PR M: x8 • 1- slot PR M: x16   | Port3C      | E2/04/<br>0            | E4/00/<br>0          | FHHL         |

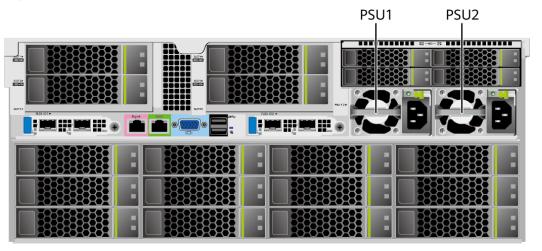
| PCIe<br>Slot | CPU | PCIe<br>Stand<br>ards | Conne<br>ctor<br>Width | Bus<br>Width | Port<br>No. | Root<br>Port<br>(B/D/F<br>) | Devic<br>e<br>(B/D/F<br>) | Slot<br>Size |
|--------------|-----|-----------------------|------------------------|--------------|-------------|-----------------------------|---------------------------|--------------|
|--------------|-----|-----------------------|------------------------|--------------|-------------|-----------------------------|---------------------------|--------------|

- a: When CPU1 and CPU2 use x8 signals, the socket-direct function is supported. FlexIO cards 1 and 2 are not supported to expand the PCle bandwidth at the same time.
- The B/D/F (Bus/Device/Function Number) is the default value when the server is fully configured with PCIe cards. The value may differ if the server is not fully configured with PCIe cards or if a PCIe card with a PCI bridge is configured.
- Root Port (B/D/F) indicates the B/D/F of an internal PCle root port of the processor.
- Device (B/D/F) indicates the B/D/F (bus address displayed on the OS) of an onboard or extended PCIe device.
- The PCle x16 slots are compatible with PCle x16, PCle x8, PCle x4, and PCle x1 cards. The PCle cards are not forward compatible. That is, the PCle slot width cannot be smaller than the PCle card link width.
- The full-height full-length (FHFL) PCIe slots are compatible with FHFL PCIe cards, full-height half-length (FHHL) PCIe cards, and half-height half-length (HHHL) PCIe cards.
- The full-height half-length (FHHL) PCIe slots are compatible with FHHL PCIe cards and half-height half-length (HHHL) PCIe cards.
- The maximum power supply of each PCle slot is 75 W.

## 5.8 PSUs

- The server supports one or two PSUs.
- The server supports AC or DC PSUs.
- The PSUs are hot-swappable.
- The server supports two PSUs in 1+1 redundancy.
- PSUs of the same P/N code must be used in a server.
- The PSUs are protected against short circuit. Double-pole fuse is provided for the PSUs with dual input live wires.
- If the DC power supply is used, purchase the DC power supply that meets the requirements of the safety standards or the DC power supply that has passed the CCC certification.
- For details about the optional components, consult the local sales representative or see "Search Parts" in the compatibility list on the technical support website.

Figure 5-43 PSU positions



# 5.9 Fan Modules

- The server supports four fan modules.
- The fan modules are hot-swappable.
- N+1 redundancy is supported. That is, the server can work properly when a single fan fails.
- The fan speed can be adjusted.
- Fan modules of the same P/N code must be used in a server.

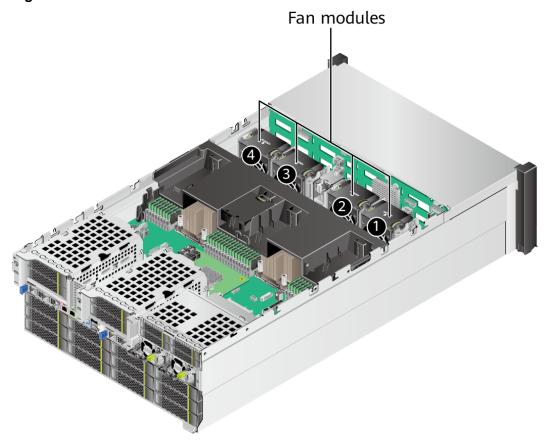
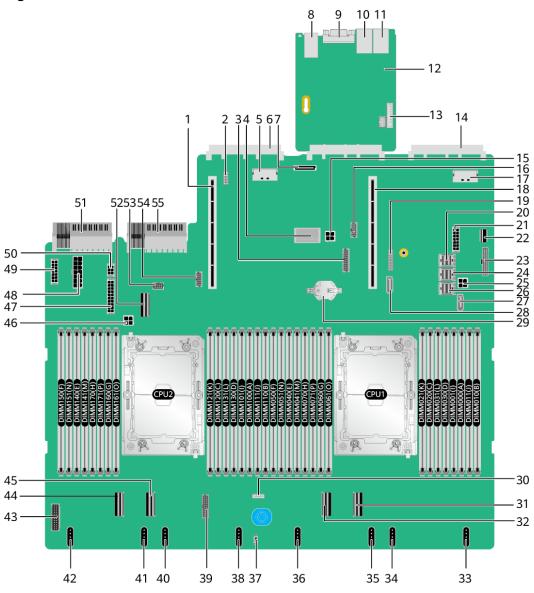


Figure 5-44 Positions of fan modules

# 5.10 Boards

# 5.10.1 Mainboard

Figure 5-45 5288 V6 mainboard



| 1 | PCIe riser 2 slot (PCIE<br>RISER2(CPU2)/J51)  | 2 | Debug pin (J103)  |
|---|---|---|---|
| 3 | Rear-drive backplane &<br>BBU low-speed signal<br>connector (BACK HDD<br>BP&BBU SIGNAL/J90) | 4 | Screw-in RAID controller<br>card connector (RAID<br>CARD/J86) |
| 5 | Slimline 7 connector for OCP 3.0 network adapter 2 (SLIMLINE7/J31)                          | 6 | OCP 3.0 network adapter 2 connector (OCP2 CONN/ J109)         |

| 7  | Built-in storage expansion port (SD CARD/J87)                      | 8  | 2 x USB 3.0 ports (USB3.0<br>CONN/J88)                |
|----|--|----|---|
| 9  | Rear VGA port (VGA<br>CONN/J60)                                    | 10 | Serial port (COM/J6020)                               |
| 11 | BMC management network port (BMC_GE /J6019)                        | 12 | BMC management board                                  |
| 13 | LCD connector (LCD CONN/J6025) <sup>a</sup>                        | 14 | OCP 3.0 network adapter 1 connector (OCP1 CONN/ J108) |
| 15 | Rear-drive backplane<br>power connector 2 (REAR<br>BP PWR2/J21)    | 16 | NC-SI connector (NCSI<br>CONN/J114)                   |
| 17 | Slimline 6 connector for OCP 3.0 network adapter 1 (SLIMLINE6/J13) | 18 | PCIe riser 1 slot (PCIE<br>RISER1(CPU1)/J50)          |
| 19 | TPM/TCM connector (J10)  | 20 | Mini-SAS HD connector C<br>(MINIHD PORTC/J4)          |
| 21 | Drive backplane power<br>connector 3 (HDD BP<br>PWR3/J89)          | 22 | Built-in USB 3.0 connector<br>(INNER USB3.0/J110)     |
| 23 | Right mounting ear connector (RCIA BOARD/ J113)                    | 24 | Mini-SAS HD connector B (MINIHD PORTB/J5)             |
| 25 | Rear-drive backplane<br>power connector 1 (REAR<br>BP PWR1/J64)    | 26 | Mini-SAS HD connector A (MINIHD PORTA/J6)             |
| 27 | SATA connector 1<br>(SATA1/J1)                                     | 28 | SATA connector 2<br>(SATA2/J2)                        |
| 29 | Cell battery holder (U9)   | 30 | VROC key connector (Soft RAID KEY/J3) <sup>a</sup>    |
| 31 | LP slimline 1 connector (SLIMLNE1(CPU1)/J11)                       | 32 | LP slimline 2 connector (SLIMLNE2(CPU1)/J84)          |
| 33 | Fan module 4 connector (J100) <sup>a</sup>                         | 34 | Fan module 4 connector (2U FAN4/J98)                  |
| 35 | Fan module 3 connector (J97) <sup>a</sup>                          | 36 | Fan module 3 connector (2U FAN3/J95)                  |
| 37 | Intrusion sensor connector (INTRUDER CONN/S1)                      | 38 | Fan module 2 connector (J93) <sup>a</sup>             |

| 39         | Low-speed signal<br>connector for the front-<br>drive backplane (FRONT<br>HDD BP/J75)    | 40 | Fan module 2 connector<br>(2U FAN2/J91)   |  |  |  |
|------------|--|----|---|--|--|--|
| 41         | Fan module 1 connector (J102) <sup>a</sup>   | 42 | Fan module 1 connector (2U FAN1/J67)  |  |  |  |
| 43         | Left mounting ear connector (LCIA BOARD/ J106)   | 44 | LP slimline 4 connector (SLIMLINE4(CPU2)/J12)   |  |  |  |
| 45         | LP slimline 3 connector (SLIMLINE3(CPU2)/J85)  | 46 | Power connector for the built-in-drive backplane (INNER HDD PWR/J22)                      |  |  |  |
| 47         | Drive backplane power<br>connector 2 (HDD BP<br>PWR2/J88)                                | 48 | BBU power connector<br>(BBU POWER/J13001)   |  |  |  |
| 49         | Drive backplane power<br>connector 1 (HDD BP<br>PWR1/J26)                                | 50 | Rear-drive backplane<br>power connector 3 (REAR<br>BP PWR3/J20)                           |  |  |  |
| 51         | PSU 2 connector (PSU2/<br>J56)   | 52 | LP slimline 5 connector (SLIMLINE5(CPU2)/J30)   |  |  |  |
| 53         | Low-speed signal<br>connector for the built-in-<br>drive backplane (INNER<br>HDD BP/J27) | 54 | Rear 4 x 2.5" drive<br>backplane low-speed<br>signal connector (REAR<br>4*2.5 HDD BP/J57) |  |  |  |
| 55         | PSU1 connector (PSU1/<br>J28)  | -  | -   |  |  |  |
| a: Reserve | a: Reserved and unavailable currently.   |    |   |  |  |  |

# 5.10.2 Drive Backplane

## **Front-Drive Backplane**

• 24 x 3.5" drive EXP backplane

2 3 5 11 10 9 8

Figure 5-46 24 x 3.5" drive EXP backplane

| 1  | Indicator signal connector (REAR BP0/J32)        | 2  | Mini-SAS HD connector<br>(PORT B/J29)    |
|----|--|----|--|
| 3  | Mini-SAS HD connector<br>(PORT A/J28)            | 4  | Mini-SAS HD connector<br>(REAR PORT/J31) |
| 5  | Backplane signal<br>connector (MAIN<br>BOARD/J1) | 6  | Power connector<br>(POWER/J61)           |
| 7  | Signal connector (REAR BP1/J35)                  | 8  | Mini-SAS HD connector<br>(PORT C/J2)     |
| 9  | Mini-SAS HD connector<br>(PORT B/J64)            | 10 | Mini-SAS HD connector<br>(PORT A/J63)    |
| 11 | Backplane signal connector (HDDBP/J36)           | -  | -  |

## **Built-in-Drive Backplane**

4 x 3.5" drive backplane

Figure 5-47 4 x 3.5" drive backplane

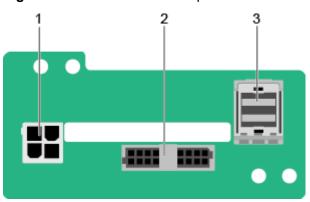


| 1 | mini-SAS HD connector<br>(PORT A/J3)               | 2 | Backplane signal cable<br>connector (INNER HDD<br>BP/J1) |
|---|--|---|--|
| 3 | Backplane power<br>connector (INNER HDD<br>PWR/J2) | - | -  |

## **Rear-Drive Backplane**

• 2 x 2.5" drive backplane

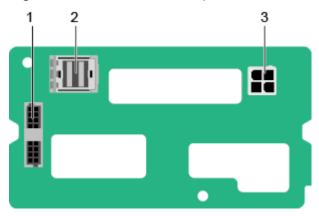
Figure 5-48 2 x 2.5" drive backplane



| 1 | Power connector (BP PWR/J1)             | 2 | Indicator signal cable connector (REAR BP/J5) |
|---|---|---|---|
| 3 | mini-SAS HD connector<br>(REAR PORT/J2) | - | -   |

• 2 x 3.5" drive backplane

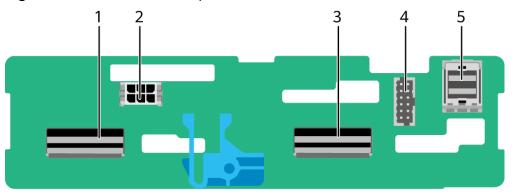
Figure 5-49 2 x 3.5" drive backplane



| 1 | Indicator signal cable connector (REAR BP/J5) | 2 | mini-SAS HD connector<br>(REAR PORT/J2) |
|---|---|---|---|
| 3 | Power connector (BP PWR/J1)                   | - | -                                       |

#### • 4 x 2.5" drive backplane

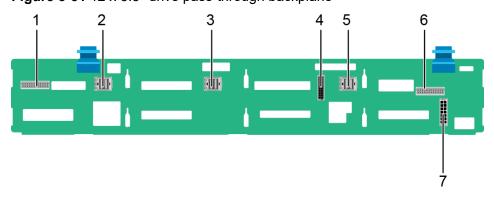
Figure 5-50 4 x 2.5" drive backplane



| 1 | LP slimline 4 connector (SLIM_4/J1001) | 2 | Power connector<br>(POWR/J2502)                        |
|---|--|---|--|
| 3 | LP slimline 3 connector (SLIM_3/J901)  | 4 | Backplane signal cable<br>connector (HDD BP/<br>J2302) |
| 5 | mini-SAS HD connector<br>(Port A/J801) | - | -  |

## • 12 x 3.5" drive pass-through backplane

Figure 5-51 12 x 3.5" drive pass-through backplane



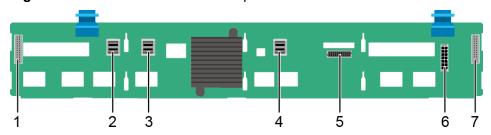
| 1 Indicator signal cable connector (REAR BP0/J7) | 2 | mini-SAS HD connector<br>(PORT C/J5) |
|--|---|--------------------------------------|
|--|---|--------------------------------------|

| 3 | mini-SAS HD connector<br>(PORT B/J4) | 4 | Backplane signal cable connector (HDD BP/J6)   |
|---|--------------------------------------|---|--|
| 5 | mini-SAS HD connector<br>(PORT A/J3) | 6 | Indicator signal cable connector (REAR BP1/J8) |
| 7 | Power connector<br>(POWER/J1)        | - | -  |

## • 12 x 3.5" drive EXP backplane

This backplane is supported by Dual-RAID configuration 3 in **5.5.1 Drive Configurations**.

Figure 5-52 12 x 3.5" drive EXP backplane



| 1 | Indicator signal cable<br>connector (REAR BP0/<br>J31) | 2 | mini-SAS HD connector<br>(PORT A/J28)    |
|---|--|---|--|
| 3 | mini-SAS HD connector<br>(PORT B/J29)                  | 4 | mini-SAS HD connector<br>(REAR PORT/J34) |
| 5 | Backplane signal cable connector (HDD BP/J35)          | 6 | Power connector<br>(POWER/J24)           |
| 7 | Indicator signal cable<br>connector (REAR BP1/<br>J32) | - | -  |

# 6 Product Specifications

- 6.1 Technical Specifications
- 6.2 Environmental Specifications
- 6.3 Physical Specifications

# **6.1 Technical Specifications**

Table 6-1 Technical specifications

| Component   | Specifications   |  |
|-------------|--|--|
| Form Factor | 4U rack server   |  |
| Chipset     | Intel® C621A   |  |
| Processor   | Supports one or two processors.  |  |
|             | Third-generation Intel <sup>®</sup> Xeon <sup>®</sup> Scalable Ice Lake processors   |  |
|             | Built-in memory controller and eight memory channels<br>per processor  |  |
|             | Built-in PCle controller, supporting PCle 4.0 and 64 lanes per processor   |  |
|             | <ul> <li>Three UPI buses between processors, providing up to<br/>11.2 GT/s transmission per channel</li> </ul>                                     |  |
|             | Up to 40 cores   |  |
|             | • Max. 3.6 GHz   |  |
|             | Min. 1.5 MB L3 cache per core  |  |
|             | Max. 270 W TDP   |  |
|             | NOTE  The preceding information is for reference only. For details, see "Search Parts" in the compatibility list on the technical support website. |  |

| Component | Specifications  |
|-----------|---|
| DIMM      | Supports 32 memory module slots.  |
|           | Up to 32 DDR4 memory modules  |
|           | <ul> <li>RDIMM and LRDIMM support</li> </ul>  |
|           | <ul> <li>Max. 3200 MT/s memory speed</li> </ul>   |
|           | <ul> <li>The DDR4 memory modules of different types<br/>(RDIMM and LRDIMM) and specifications<br/>(capacity, bit width, rank, and height) cannot be<br/>used together.</li> </ul> |
|           | <ul> <li>A server must use DDR4 memory modules of the<br/>same P/N code.</li> </ul>   |
|           | Up to 16 PMem modules   |
|           | <ul> <li>The PMem modules must be used with the DDR4<br/>memory modules, and only one PMem module can<br/>be installed in each memory channel.</li> </ul>                         |
|           | <ul> <li>The PMem modules support the AD or MM mode.</li> </ul>   |
|           | <ul> <li>Max. 3200 MT/s memory speed</li> </ul>   |
|           | <ul> <li>The PMem modules of different specifications<br/>(capacity and rank) cannot be used together.</li> </ul>   |
|           | <ul> <li>For details about the PMem modules, see PMem<br/>200-Barlow pass User Guide.</li> </ul>  |
|           | NOTE  The preceding information is for reference only. For details, see "Search Parts" in the compatibility list on the technical support website.                                |

| Component | Specifications  |
|-----------|---|
| Storage   | Supports a variety of drive configurations. For details, see <b>5.5.1 Drive Configurations</b> .  |
|           | Supports two M.2 SSDs.  |
|           | <ul> <li>M.2 SSDs are supported for RAID 0/1 and hot<br/>swap without opening the chassis cover is<br/>supported when the server is configured with an<br/>Avago SAS3004iMR RAID controller card.</li> </ul>  |
|           | NOTE  |
|           | <ul> <li>The M.2 SSD is used only as a boot device for installing<br/>the OS. Small-capacity (32 GB or 64 GB) M.2 SSDs do<br/>not support logging due to poor endurance. If a small-<br/>capacity M.2 SSD is used as the boot device, a<br/>dedicated log drive or log server is required for logging.</li> <li>For example, you can dump VMware logs in either of the<br/>following ways:</li> </ul> |
|           | <ul> <li>Redirect /scratch. For details, see https://<br/>kb.vmware.com/s/article/1033696.</li> </ul>   |
|           | <ul> <li>Configure syslog. For details, see <a href="https://kb.vmware.com/s/article/2003322">https://kb.vmware.com/s/article/2003322</a>.</li> </ul>   |
|           | <ul> <li>The M.2 SSD cannot be used to store data due to poor<br/>endurance. In write-intensive applications, the M.2 SSD<br/>will wear out in a short time.</li> <li>If you want to use SSDs or HDDs as data storage<br/>devices, use enterprise-level SSDs or HDDs with high<br/>DWPD.</li> </ul>   |
|           | <ul> <li>The M.2 SSD is not recommended for write-intensive<br/>service software due to poor endurance.</li> </ul>  |
|           | <ul> <li>Do not use M.2 SSDs for cache.</li> </ul>  |
|           | Supports hot swap of SAS/SATA/NVMe U.2 drives.  |
|           | NOTE The NVMe drives support:   |
|           | <ul> <li>Before using the VMD function, contact technical support<br/>engineers of the OS vendor to check whether the OS<br/>supports the VMD function. If yes, check whether the<br/>VMD driver needs to be manually installed and check the<br/>installation method.</li> </ul>   |
|           | <ul> <li>Surprise hot swap if the VMD function is enabled and the<br/>latest Intel VMD driver is installed.</li> </ul>  |
|           | <ul> <li>Orderly hot swap if the VMD function is disabled.</li> </ul>   |
|           | Supports a variety of RAID controller cards. For details, see "Search Parts" in the compatibility list on the technical support website.  |
|           | <ul> <li>The RAID controller card supports RAID<br/>configuration, RAID level migration, and drive<br/>roaming.</li> </ul>  |
|           | <ul> <li>The RAID controller card supports a<br/>supercapacitor for power-off protection, which<br/>improves drive storage performance and ensures<br/>user data security.</li> </ul>   |

| Component     | Specifications  |
|---------------|---|
|               | The PCIe RAID controller card occupies one PCIe slot.   |
|               | For details about the RAID controller card, see server RAID Controller Card User Guide.   |
|               | NOTE If the BIOS is in legacy mode, the 4K drive cannot be used as the boot drive.  |
| Network       | Supports expansion capability of multiple types of networks.  |
|               | OCP 3.0 network adapter   |
|               | <ul> <li>The two FlexIO card slots support two OCP 3.0<br/>network adapter respectively, which can be<br/>configured as required.</li> </ul>  |
|               | <ul> <li>Supports orderly hot swap.</li> </ul>  |
|               | NOTE  The OCP 3.0 network adapter supports orderly hot swap only when the VMD function is disabled.   |
|               | <ul> <li>Supports a variety of OCP 3.0 network adapters.</li> <li>For details, see "Search Parts" in the compatibility list on the technical support website.</li> </ul>  |
| I/O expansion | Supports 11 PCIe 4.0 slots.   |
|               | One PCle slot dedicated for a screw-in RAID controller card, two FlexIO slots dedicated for OCP 3.0 network adapters, and eight PCle slots for standard PCle cards.  For details, see 5.7.2 PCle Slots and 5.7.3 PCle Slot Description. |
|               | NOTE  The preceding information is for reference only. For details, see "Search Parts" in the compatibility list on the technical support website.  |

| Component         | Specifications  |  |
|-------------------|---|--|
| Port              | Supports a variety of ports.  |  |
|                   | Ports on the front panel:   |  |
|                   | One USB Type-C iBMC direct connect management port  |  |
|                   | <ul><li>Two USB 3.0 ports</li></ul>   |  |
|                   | <ul><li>One DB15 VGA port</li></ul>   |  |
|                   | Ports on the rear panel:  |  |
|                   | <ul><li>Two USB 3.0 ports</li></ul>   |  |
|                   | <ul><li>One DB15 VGA port</li></ul>   |  |
|                   | One RJ45 serial port  |  |
|                   | <ul> <li>One RJ45 management network port</li> </ul>  |  |
|                   | Built-in ports:   |  |
|                   | <ul><li>One USB 3.0 port</li></ul>  |  |
|                   | <ul><li>Two SATA ports</li></ul>  |  |
|                   | NOTE You are not advised to install the operating system on the USB storage media.  |  |
| Video card        | An SM750 video chip with 32 MB display memory is integrated on the mainboard. The maximum display resolution is 1920 x 1200 at 60 Hz with 16 M colors.  |  |
|                   | The integrated video card can provide the maximum display resolution (1920 x 1200) only after the video card driver matching the operating system version is installed. Otherwise, only the default resolution supported by the operating system is provided. |  |
|                   | <ul> <li>If both the front and rear VGA ports are connected to<br/>monitors, only the monitor connected to the front VGA port<br/>displays information.</li> </ul>  |  |
| System management | • UEFI  |  |
|                   | • iBMC  |  |
|                   | NC-SI   |  |
|                   | Integration with third-party management systems   |  |
| Security feature  | Power-on password   |  |
|                   | Administrator password  |  |
|                   | TCM (only in China)/TPM   |  |
|                   | Secure boot   |  |
|                   | Front bezel (optional)  |  |
|                   | Chassis cover opening detection   |  |

# **6.2 Environmental Specifications**

Table 6-2 Environmental specifications

| Category               | Specifications   |
|------------------------|--|
| Temperature            | Operating temperature: 5°C to 45°C (41°F to 113°F)     (ASHRAE Classes A1 to A4 compliant)   |
|                        | • Storage temperature (within three months): -30°C to +60°C (-22°F to 140°F)   |
|                        | <ul> <li>Storage temperature (within six months): -15°C to<br/>+45°C (5°F to 113°F)</li> </ul>   |
|                        | <ul> <li>Storage temperature (within one year): -10°C to<br/>+35°C (14°F to 95°F)</li> </ul>   |
|                        | Maximum rate of temperature change: 20°C (36°F) per hour, 5°C (9°F) per 15 minutes   |
|                        | NOTE  The highest operating temperature varies depending on the server configuration. For details, see A.3 Operating Temperature Limitations.  |
| Relative humidity (RH, | Operating humidity: 8% to 90%  |
| non-condensing)        | Storage humidity (within three months): 8% to 85%  |
|                        | Storage humidity (within six months): 8% to 80%  |
|                        | Storage humidity (within one year): 20% to 75%   |
|                        | Maximum humidity change rate: 20%/h  |
| Air volume             | ≥ 273 cubic feet per minute (CFM)  |
| Operating altitude     | ≤ 3050 m (10006.56 ft)   |
|                        | When the server configuration complies with ASHRAE Classes A1 and A2 and the altitude is above 900 m (2952.76 ft), the highest operating temperature decreases by 1°C (1.8°F) for every increase of 300 m (984.24 ft).                       |
|                        | When the server configuration complies with ASHRAE Class A3 and the altitude is above 900 m (2952.76 ft), the highest operating temperature decreases by 1°C (1.8°F) for every increase of 175 m (574.14 ft).                                |
|                        | <ul> <li>When the server configuration complies with ASHRAE<br/>Class A4 and the altitude is above 900 m (2952.76 ft),<br/>the highest operating temperature decreases by 1°C<br/>(1.8°F) for every increase of 125 m (410.1 ft).</li> </ul> |
|                        | HDDs cannot be used at an altitude of over 3050 m (10006.44 ft).   |

| Category                      | Specifications   |  |
|-------------------------------|--|--|
| Corrosive gaseous contaminant | Maximum corrosion product thickness growth rate:   |  |
|                               | Copper corrosion rate test: 300 Å/month (meeting level G1 requirements of the ANSI/ISA-71.04-2013 standard on gaseous corrosion)   |  |
|                               | Silver corrosion rate test: 200 Å/month  |  |
| Particle contaminant          | The equipment room environment meets the requirements of ISO 14664-1 Class 8.  |  |
|                               | There is no explosive, conductive, magnetic, or corrosive dust in the equipment room.  |  |
|                               | NOTE It is recommended that the particulate pollutants in the equipment room be monitored by a professional organization.  |  |
| Acoustic noise                | The declared A-weighted sound power levels (LWAd) and declared average bystander position A-weighted sound pressure levels (LpAm) listed are measured at 23°C (73.4°F) in accordance with ISO 7779 (ECMA 74) and declared in accordance with ISO 9296 (ECMA 109).  • Idle: |  |
|                               | <ul><li>LWAd: 6.56 Bels</li></ul>  |  |
|                               | – LpAm: 51.2 dBA   |  |
|                               | Operating:   |  |
|                               | <ul><li>LWAd: 7.03 Bels</li></ul>  |  |
|                               | <ul><li>– LpAm: 55.9 dBA</li></ul>   |  |
|                               | NOTE Actual sound levels generated during server operation vary depending on server configuration, load, and ambient temperature.  |  |

#### **◯** NOTE

SSDs and HDDs (including NL-SAS, SAS, and SATA) cannot be preserved for a long time in the power-off state. Data may be lost or faults may occur if the preservation duration exceeds the specified maximum duration. When drives are preserved under the storage temperature and humidity specified in the preceding table, the following preservation time is recommended:

- Maximum preservation duration of SSDs:
  - 12 months in power-off state without data stored
  - 3 months in power-off state with data stored
- Maximum preservation duration of HDDs:
  - 6 months in unpacked/packed and powered-off state
- The maximum preservation duration is determined according to the preservation specifications provided by drive vendors. For details, see the manuals provided by drive vendors.

# **6.3 Physical Specifications**

Table 6-3 Physical specifications

| Item                                | Description  |
|-------------------------------------|--|
| Dimensions (H x W x D)              | 175 mm × 447 mm × 790 mm (6.89 in. x 17.60 in. x 31.10 in.)  |
|                                     | Figure 6-1 Physical dimensions   |
|                                     | NOTE  See Figure 6-1 for methods in measuring physical dimensions of the chassis.  |
| Installation dimension requirements | Requirements for cabinet installation:     19-inch standard cabinet compliant with the International     Electrotechnical Commission (IEC) 297 standard                                  |
|                                     | - Cabinet width: 482.6 mm (19.00 in.)  |
|                                     | <ul> <li>Cabinet depth ≥ 1000 mm (39.37 in.)</li> </ul>  |
|                                     | Requirements for guide rail installation:  |
|                                     | <ul> <li>L-shaped guide rails are only for xFusion cabinets.</li> </ul>  |
|                                     | <ul> <li>Adjustable L-shaped guide rail: apply to cabinets with a<br/>distance of 543.5 mm to 848.5 mm (21.40 in. to 33.41 in.)<br/>between the front and rear mounting bars.</li> </ul> |
|                                     | <ul> <li>Ball bearing rail kit: applies to cabinets with a distance of 610 mm to 914 mm (24.02 in. to 35.98 in.) between the front and rear mounting bars.</li> </ul>                    |
| Fully equipped weight               | Maximum weight of fully-equipped drives: 65 kg (143.30 lb)   |
|                                     | Packaging materials: 5 kg (11.03 lb)   |

| Item               | Description  |
|--------------------|--|
| Energy consumption | The power consumption parameters vary with hardware configurations (including the configurations complying with EU ErP). For details, see Power Calculator on the technical support website. |

# Software and Hardware Compatibility

see the compatibility list on the technical support website to obtain information about the operating systems and hardware supported.

#### NOTICE

- If incompatible components are used, the device may be abnormal. This fault is beyond the scope of technical support and warranty.
- The performance of servers is closely related to application software, basic middleware software, and hardware. The slight differences of the application software, middleware basic software, and hardware may cause performance inconsistency between the application layer and test software layer.
  - If the customer has requirements on the performance of specific application software, contact technical support to apply for POC tests in the pre-sales phase to determine detailed software and hardware configurations.
  - If the customer has requirements on hardware performance consistency, specify the specific configuration requirements (for example, specific drive models, RAID controller cards, or firmware versions) in the pre-sales phase.

# 8 Safety Instructions

- 8.1 Security
- 8.2 Maintenance and Warranty

### 8.1 Security

#### **General Statement**

- Comply with local laws and regulations when installing devices. These Safety Instructions are only a supplement.
- The "DANGER", "WARNING", and "CAUTION" information in this document does not represent all the safety instructions, but supplements to the safety instructions.
- Observe all safety instructions provided on the device labels when installing hardware. Follow them in conjunction with these Safety Instructions.
- Only qualified personnel are allowed to perform special tasks, such as performing high-voltage operations and driving a forklift.



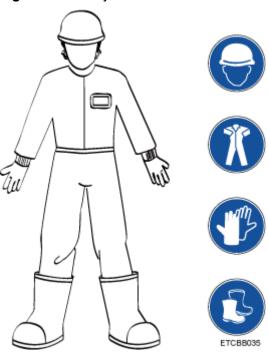
If this device works in a residential environment, the wireless interference may be generated.

#### **Personal Safety**

- This equipment is not suitable for use in places where children may be present.
- Only personnel certified or authorized are allowed to install equipment.
- Discontinue any dangerous operations and take protective measures. Report anything that could cause personal injury or device damage to a project supervisor.
- Do not move devices or install racks and power cables in hazardous weather conditions.

- Do not carry the weight that is over the maximum load per person allowed by local laws or regulations. Before moving or installing equipment, check the maximum equipment weight and arrange required personnel.
- Wear clean protective gloves, ESD clothing, a protective hat, and protective shoes, as shown in **Figure 8-1**.

Figure 8-1 Safety work wear



 Before touching a device, wear ESD clothing and gloves (or wrist strap), and remove any conductive objects (such as watches and jewelry). Figure 8-2 shows conductive objects that must be removed before you touch a device.

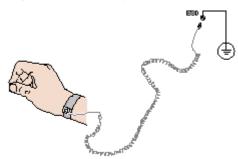
Figure 8-2 Removing conductive objects



Figure 8-3 shows how to wear an ESD wrist strap.

- a. Put your hands into the ESD wrist strap.
- b. Tighten the strap buckle and ensure that the ESD wrist strap is in contact with your skin.
- c. Insert the ground terminal attached to the ESD wrist strap into the jack on the grounded rack or chassis.

Figure 8-3 Wearing an ESD wrist strap



- Exercise caution when using tools.
- If the installation position of a device is higher than the shoulders of the installation personnel, use a vehicle such as a lift to facilitate installation. Prevent the device from falling down and causing personal injury or damage to the device.
- The equipment is powered by high-voltage power sources. Direct or indirect contact (especially through damp objects) with high-voltage power sources may result in serious injury or death.
- Ground the equipment before powering it on. Otherwise, personal injury may be caused by high electricity leakage.
- When a ladder is used, ensure that another person holds the ladder steady to prevent accidents.
- Do not look into optical ports without eye protection.

#### **Device Security**

- Use the recommended power cables at all times.
- Use power cables only for dedicated servers. Do not use them for other devices.
- Before operating equipment, wear ESD clothes and gloves to prevent electrostatic-sensitive devices from being damaged by ESD.
- When moving a device, hold the bottom of the device. Do not hold the handles of the installed modules, such as the PSUs, fan modules, drives, and the mainboard. Handle the equipment with care.
- Exercise caution when using tools.
- Connect the primary and secondary power cables to different power distribution units (PDUs) to ensure reliable system operation.
- Ground a device before powering it on. Otherwise, high leakage current may cause device damage.

#### **Transportation Precautions**

Improper transportation may damage equipment. Contact the manufacturer for precautions before attempting transportation.

Transportation precautions include but are not limited to:

 The logistics company engaged to transport the device must be reliable and comply with international standards for transporting electronics. Ensure that the equipment being transported is always kept upright. Take necessary precautions to prevent collisions, corrosion, package damage, damp conditions and pollution.

- Transport each device in its original packaging.
- If the original packaging is unavailable, package heavy, bulky parts (such as chassis and blades) and fragile parts (such as PCIe cards and optical modules) separately.

■ NOTE

For details about the components supported by the server, see "Search Parts" in the compatibility list on the technical support website

Power off all devices before transportation.

#### **Maximum Weight Carried by a Person**



Comply with local regulations for the maximum load per person.

**Table 8-1** lists the maximum weight one person is permitted to carry as stipulated by a number of organizations.

Table 8-1 Maximum weight carried per person

| Organization  | Weight (kg/lb) |  |
|---|----------------|--|
| European Committee for Standardization (CEN)                  | 25/55.13       |  |
| International Organization for Standardization (ISO)          | 25/55.13       |  |
| National Institute for Occupational Safety and Health (NIOSH) | 23/50.72       |  |
| Health and Safety Executive (HSE)                             | 25/55.13       |  |

For more information about safety instructions, see server Safety Information.

# 8.2 Maintenance and Warranty

For details about the maintenance policy, visit the **technical support website** > **service support** > **Customer Support Service**.

For details about the warranty policy, visit the **technical support website** > **service support** > **warranty**.

# 9 System Management

This product integrates the new-generation Intelligent Baseboard Management Controller (iBMC), which complies with Intelligent Platform Management Interface 2.0 (IPMI 2.0) specifications and provides reliable hardware monitoring and management.

The iBMC provides the following features:

Various management interfaces

The iBMC provides the following standard interfaces to meet various system integration requirements:

- DCMI 1.5 interface
- IPMI 1.5/IPMI 2.0 interface
- CLI
- Redfish interface
- HTTPS
- SNMP
- Fault detection and alarm management

Faults can be detected and rectified in advance to ensure 24/7 stable running of the device.

- The iBMC allows screenshots and videos to be created when the system breaks down, facilitating cause analysis of the system breakdown.
- The iBMC offers screen snapshots and videos, simplifying routine preventive maintenance, recording, and auditing.
- The FDM function supports component-based precise fault diagnosis, facilitating component fault locating and replacement.
- The iBMC supports the reporting of alarms through syslog packets, trap packets, and emails, helping the upper-layer NMS to collect the fault information about the server.
- Security management
  - Software image backup improves system security. Even if the running software breaks down, the system can be started from the backup image.
  - Diversified user security control interfaces are provided to ensure user login security.

- Multiple types of certificates can be imported and replaced to ensure data transmission security.
- System maintenance interface
  - The virtual KVM and virtual media functions facilitate remote maintenance.
  - The iBMC supports out-of-band RAID monitoring and configuration to improve RAID configuration efficiency and management capabilities.
  - Smart Provisioning provides a convenient operation interface for installing the OS, configuring RAID, and performing the upgrade without a CD-ROM.
- Various network protocols
  - The NTP synchronizes network time to optimize time configuration.
  - The iBMC supports domain name system (DNS) and Lightweight Directory Application Protocol (LDAP) to implement domain management and directory service.
- Intelligent power management
  - The power capping technology helps you easily improve deployment density.
  - The iBMC uses dynamic power saving to reduce operational expenditure (OPEX).
- License management

By managing licenses, you can use the features of the iBMC advanced edition in authorization mode.

Compared with the standard edition, the iBMC advanced edition provides more advanced features, such as:

- Implements the OS deployment using Redfish.
- Collect the original data of intelligent diagnosis using Redfish.

# 10 Certifications

| Country/Region Certification St |          | Standards                          |  |
|---------------------------------|----------|------------------------------------|--|
| Europe                          | WEEE     | 2012/19/EU                         |  |
| Europe                          | REACH    | EC NO. 1907/2006                   |  |
| Europe                          | CE       | Safety:                            |  |
|                                 |          | EN 62368-1:2014+A11:2017           |  |
|                                 |          | EMC:                               |  |
|                                 |          | EN 55032:2015+A11:2020             |  |
|                                 |          | CISPR 32:2015+A1:2019              |  |
|                                 |          | EN IEC 61000-3-2:2019+A1:2021      |  |
|                                 |          | EN 61000-3-3:2013+A1:2019          |  |
|                                 |          | EN 55035:2017+A11:2020             |  |
|                                 |          | CISPR 35:2016                      |  |
|                                 |          | EN 55024:2010+A1:2015              |  |
|                                 |          | CISPR 24:2010+A1:2015              |  |
|                                 |          | ETSI EN 300 386 V1.6.1:2012        |  |
|                                 |          | ETSI EN 300 386 V2.1.1:2016        |  |
|                                 |          | RoHS:                              |  |
|                                 |          | EN IEC 63000:2018                  |  |
|                                 |          | ErP:                               |  |
|                                 |          | Commission Regulation(EU) 424/2019 |  |
| Russia                          | EAC&GOST | ГОСТ CISPR 32-2015                 |  |
|                                 |          | ГОСТ CISPR 24-2013                 |  |
|                                 |          | ГОСТ 30804 3.2-2013                |  |
|                                 |          | ГОСТ 30804 3.3-2013                |  |
|                                 |          | ГОСТ 15150-69                      |  |

| Country/Region | Certification | Standards  |
|----------------|---------------|--|
| UK             | UKCA          | Safety: EN 62368-1:2014+A11:2017 EMC: EN 55032:2015+A11:2020 CISPR 32:2015+A1:2019 EN IEC 61000-3-2:2019+A1:2021 EN 61000-3-3:2013+A1:2019 EN 55035:2017+A11:2020 CISPR 35:2016 EN 55024:2010+A1:2015 CISPR 24:2010+A1:2015 ETSI EN 300 386 V1.6.1:2012 ETSI EN 300 386 V2.1.1:2016 RoHS: BS EN IEC 63000:2018 ErP: Commission Regulation(EU) 424/2019 |
| US             | FCC           | FCC PART 15  |
| Canada         | IC            | ICES-003   |
| China          | CCC           | GB 17625.1-2022<br>GB 4943.1-2022<br>GB/T 9254.1-2021 (Class A)  |
| China          | RoHS          | SJ/T-11364<br>GB/T 26572   |
| Japan          | VCCI          | VCCI 32-1  |
| Global         | СВ            | IEC 62368-1:2014   |

# 1 1 Waste Product Recycling

If product users need product recycling service provided by xFusion after products are scrapped, contact technical support for services.



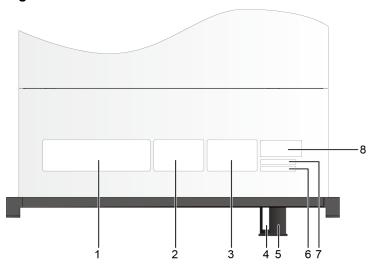
#### A.1 Chassis Label

**◯** NOTE

The label information and location are for reference only. For details, see the actual product.

### A.1.1 On the Front Top

Figure A-1 Chassis head label



| 1 | Nameplate        | 2 | Certificate  |
|---|------------------|---|--|
| 3 | Quick access tag | 4 | SN   |
|   |                  |   | <b>NOTE</b> For details, see <b>A.2 Product SN</b> . |

| 5 | Slide-out label plate  NOTE  The label locations vary with server models or configurations. For details, see 5.1.1  Appearance. | 6 | SN NOTE For details, see A.2 Product SN.  |
|---|---|---|---|
| 7 | Reserved space for custom label   | 8 | Pressure-proof label  NOTE  This label indicates that do not place any objects on top of a rack-mounted device. |

#### A.1.1.1 Nameplate

Figure A-2 Nameplate example

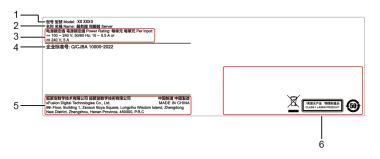


Table A-1 Nameplate description

| No. | Description                             |
|-----|---|
| 1   | Server Model                            |
|     | For details, see <b>A.4 Nameplate</b> . |
| 2   | Device names                            |
| 3   | Power Supply Requirements               |
| 4   | Enterprise Standard No.                 |
| 5   | Vendor Information                      |
| 6   | Authentication ID                       |

#### A.1.1.2 Certificate

Figure A-3 Sample certificate of conformity



Table A-2 Certificate of conformity description

| No. | Description   |
|-----|---|
| 1   | Order   |
| 2   | No.  NOTE  For details, see Figure A-4 and Table A-3. |
| 3   | QC inspector  |
| 4   | Production date                                       |
| 5   | No. Barcode   |

Figure A-4 Sample certificate number



Table A-3 Certificate No. Description

| No. | Description   |
|-----|---|
| 1   | "P", fixed  |
| 2   | "Z", fixed  |
| 3   | <ul> <li>Y: Server</li> <li>B: Semi-finished product of the whole machine.</li> <li>N: Loose spare parts</li> </ul> |

| No. | Description   |
|-----|---|
| 4   | "0", Reserved bit.  |
| 5   | Year (2 digits).  |
| 6   | Month (1 digit).  • Digits 1 to 9 indicate January to September, respectively.  • Letters A to C indicate October to December, respectively.  |
| 7   | <ul> <li>Day (1 digit).</li> <li>Digits 1 to 9 indicate the 1st to 9th</li> <li>Letters A to H indicate the 10th to 17th.</li> <li>Letters J to N indicate the 18th to 22nd.</li> <li>Letters P to Y indicate the 23rd to 31st</li> </ul> |
| 8   | Hour (1 digit).  • Digits 0 to 9 indicate 0 to 9:00.  • Letters A to H indicate 10 to 17:00.  • Letters J to N indicate 18 to 22:00.  • Letters P to Q indicate 23 to 24:00.  |
| 9   | Serial number (2 digits)  |
| 10  | Manufacturing serial number (5 digits).   |

#### A.1.1.3 Sample Quick Access Tags

Figure A-5 Sample quick access tags

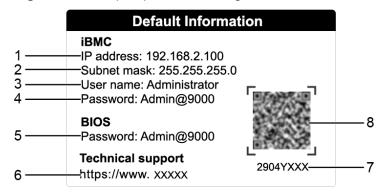


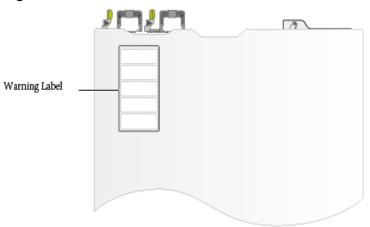
Table A-4 Quick access tab description

| No. | Description                                     |
|-----|---|
| 1   | IP address of the iBMC management network port  |
| 2   | Subnet mask of the iBMC management network port |

| No. | Description  |
|-----|--|
| 3   | Default iBMC user name   |
| 4   | Default iBMC password  |
| 5   | Default BIOS password  |
| 6   | Technical support website  |
| 7   | P/N Code   |
| 8   | QR Code  NOTE  Scan the QR code to obtain technical support resources. |

# A.1.2 Chassis Tail Label

Figure A-6 Chassis tail label

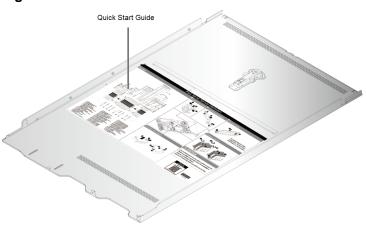


**NOTE** 

For details about the warning label, see server Safety Information.

#### A.1.3 Chassis Internal Label

Figure A-7 Chassis internal label



#### **◯** NOTE

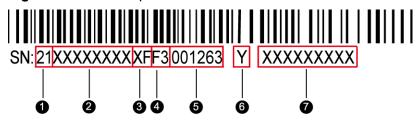
- The quick guide is located on the inside of the chassis cover. It describes how to remove
  the mainboard components, important components of the chassis, precautions, and QR
  codes of technical resources. The pictures are for reference only. For details, see the
  actual product.
- The quick guide is optional. For details, see the actual product.

#### A.2 Product SN

The serial number (SN) on the slide-out label plate uniquely identifies a device. The SN is required when you contact technical support. **Figure A-8** and **Figure A-9** show the SN formats.

SN example 1

Figure A-8 SN example 1



• SN example 2

Figure A-9 SN example 2

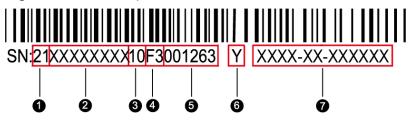


Table A-5 SN example description

| No. | Description  |  |
|-----|--|--|
| 1   | ESN ID (two characters), which can only be 21.   |  |
| 2   | Material ID (eight characters), that is, the processing code.  |  |
| 3   | Vendor code (two characters), that is, the code of the processing place.   |  |
| 4   | Year and month (two characters).   |  |
|     | The first character indicates the year.  |  |
|     | <ul> <li>Digits 1 to 9 indicate years 2001 to 2009, respectively.</li> </ul>   |  |
|     | <ul> <li>Letters A to H indicate years 2010 to 2017, respectively.</li> </ul>  |  |
|     | <ul> <li>Letters J to N indicate years 2018 to 2022, respectively.</li> </ul>  |  |
|     | <ul> <li>Letters P to Y indicate years 2023 to 2032, respectively.</li> </ul>  |  |
|     | NOTE  The years from 2010 are represented by upper-case letters excluding I, O, and Z because the three letters are similar to the digits 1, 0, and 2. |  |
|     | The second character indicates the month.  |  |
|     | Digits 1 to 9 indicate January to September, respectively.   |  |
|     | Letters A to C indicate October to December, respectively.   |  |
| 5   | Serial number (six digits).  |  |
| 6   | RoHS compliance (one character). <b>Y</b> indicates RoHS compliant.  |  |
| 7   | Internal model, that is, product name. The model format varies according to the actual situation.  |  |

# **A.3 Operating Temperature Limitations**

**Table A-6** Operating temperature limitations

| Configura<br>tion   | Maximum<br>Operating<br>Temperature<br>30°C (86°F)  | Maximum<br>Operating<br>Temperature<br>35°C (95°F)  | Maximum Operating Temperature 40°C (104°F) | Maximum<br>Operating<br>Temperature<br>45°C (113°F) |
|---|---|---|--|---|
| Single-<br>RAID or<br>dual-RAID<br>configurati<br>on (with<br>built-in<br>drives) | <ul> <li>6334/6342/6<br/>346/6348/83<br/>51N/<br/>6354/8358/8<br/>358P/<br/>8360Y/<br/>8362/8368/8<br/>380<br/>processors<br/>are not<br/>supported.</li> <li>DDR4/<br/>PMem<br/>memory<br/>modules<br/>whose<br/>capacity is<br/>256 GB per<br/>module or<br/>larger are<br/>not<br/>supported.</li> <li>T4/A2 GPU<br/>cards are<br/>not<br/>supported.</li> </ul> | <ul> <li>5320/6312U /6314U/ 6326/6330/6 334/6336Y/ 6338/6342/6 346/6348/63 54/8351N/ 8352S/ 8352Y/ 8358/8358P /8360Y/ 8362/8368/8 380 processors are not supported.</li> <li>I/O modules 1, 2, and 3 do not support 2.5-inch HDDs or NVMe SSDs.</li> <li>Rear drive modules support neither WD Vela-AP (8 TB) drives nor Vela-AX (10 TB) NL SAS drives.</li> <li>I/O module 3 not support Kioxia PM6 SAS drives.</li> <li>DDR4/ PMem</li> </ul> | • Not supported.                           | Not supported.                                      |

| Configura<br>tion | Maximum<br>Operating<br>Temperature<br>30°C (86°F) | Maximum<br>Operating<br>Temperature<br>35°C (95°F)   | Maximum<br>Operating<br>Temperature<br>40°C (104°F) | Maximum<br>Operating<br>Temperature<br>45°C (113°F) |
|-------------------|--|--|---|---|
|                   |  | memory modules whose capacity is 128 GB per module or larger are not supported.  T4 GPU cards are not supported. |   |   |

| Configura<br>tion   | Maximum<br>Operating<br>Temperature<br>30°C (86°F)  | Maximum<br>Operating<br>Temperature<br>35°C (95°F)  | Maximum Operating Temperature 40°C (104°F)   | Maximum<br>Operating<br>Temperature<br>45°C (113°F)   |
|---|---|---|--|---|
| Single-<br>RAID or<br>dual-RAID<br>configurati<br>on (with<br>built-in<br>drives) | <ul> <li>T4/A2 GPU cards are not supported when a processor with 205 W power consumption or 128 GB or larger DDR4 memory is configured.</li> <li>When 128 GB or larger DDR4 memory is configured, rear I/O module 3 does not support NVMe HDDs.</li> <li>DDR4/PMem memory modules whose capacity is 256 GB per module or larger are not supported.</li> </ul> | <ul> <li>Rear I/O module 3 does not support hard disk drives (HDDs) or NVMe SSDs when the server is configured with processors of 205 W or higher power.</li> <li>T4 GPU cards are not supported.</li> <li>DDR4/PMem memory modules whose capacity is 128 GB per module or larger are not supported.</li> <li>Rear drive modules support neither WD Vela-AP (8 TB) drives nor Vela-AX (10 TB) NL SAS drives.</li> </ul> | <ul> <li>T4 GPU cards are not supported.</li> <li>6334/6342/6 346/6348/83 51N/ 6354/8358/8 358P/ 8360Y/ 8362/8368/8 380 processors are not supported.</li> <li>I/O modules 1, 2, and 3 do not support rear drives.</li> <li>OCP 3.0 network adapters with 100Gbit/s rate or higher are not supported.</li> <li>DDR4/ PMem memory modules whose capacity is 128 GB per module or larger are not supported.</li> </ul> | <ul> <li>Only 6338T/5320T/5318Y/5318S/5318N/5317/5315Y/4316/4314/4310T/4310/4309Y processors are supported.</li> <li>RDIMMs of less than 64 GB per module are not supported.</li> <li>I/O modules 1, 2, and 3 do not support rear drives.</li> <li>GPU cards are not supported.</li> <li>NICs whose rate is greater than 25 Gbit/s are not supported.</li> <li>NICs whose rate is greater than 25 Gbit/s are not supported.</li> <li>OCP 3.0 network adapters with 25Gbit/s rate or higher are not supported.</li> <li>PCIE RAID controller card is not supported.</li> </ul> |

| Configura<br>tion | Maximum<br>Operating<br>Temperature<br>30°C (86°F) | Maximum<br>Operating<br>Temperature<br>35°C (95°F) | Maximum<br>Operating<br>Temperature<br>40°C (104°F) | Maximum<br>Operating<br>Temperature<br>45°C (113°F)                        |
|-------------------|--|--|---|--|
|                   |  |  |   | Supercapaci<br>tors are not<br>supported.                                  |
|                   |  |  |   | <ul> <li>PMem<br/>memory<br/>modules are<br/>not<br/>supported.</li> </ul> |

#### **◯** NOTE

- When a single fan is faulty, the highest operating temperature is 5°C (9°F) lower than the rated value.
- When a single fan is faulty, the system performance may be affected.
- It is recommended that servers be deployed at an interval of 1U to reduce server noise and improve server energy efficiency.
- I/O module 3 does not support hard disk drives (HDDs) when the server is configured with processors of 205 W or higher power.
- If front drives are not configured in slots 0 to 2, slots 6 to 8, slots 12 to 14, and slots 18 to 20, PMem memory modules of 512 GB per module are supported. The maximum operating temperature is 30°C (86°F).
- 8368Q 38c 270 W 2.6 GHz liquid-cooled processors are not supported.

### A.4 Nameplate

| Certified Model                                    | Remarks |  |
|--|---------|--|
| H52H-06  | Global  |  |
| 5288 V6  | Global  |  |
| Note: The nameplate depends on the actual product. |         |  |

#### A.5 RAS Features

The server supports a variety of Reliability, Availability, and Serviceability (RAS) features. You can configure these features for better performance.

For details about the RAS features, see *FusionServer Ice Lake Platform RAS Technical White Paper*.

# A.6 Sensor List

| Sensor         | Description  | Component   |
|----------------|--|---|
| Inlet Temp     | Air inlet temperature  | Right mounting ear  |
| Outlet Temp    | Air outlet temperature   | BMC card  |
| PCH Temp       | PCH bridge temperature   | Mainboard   |
| CPUN Core Rem  | CPU core temperature   | CPUN  |
|                |  | N indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| CPUN DTS       | Difference between the real-time CPU                           | CPUN  |
|                | temperature and the core CPU temperature threshold             | N indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| CpuN Margin    | Difference between the   | CPUN  |
|                | real-time CPU<br>temperature and the CPU<br>Tcontrol threshold | N indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| CPUN VDDQ Temp | CPU VDDQ temperature   | Mainboard   |
|                |  | N indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| CPUN VRD Temp  | CPU VRD temperature  | Mainboard   |
|                |  | N indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| CPUN MEM Temp  | CPU memory module temperature                                  | Memory module corresponding to CPU N                            |
|                | ·  | N indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| CPUN 12V       | 12 V voltage supplied by                                       | Mainboard   |
|                | the mainboard to the CPU                                       | N indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| Riser 12V      | 12 V voltage supplied by<br>the mainboard to the riser<br>card | Mainboard   |

| Sensor         | Description   | Component   |
|----------------|---|---|
| Disk BP 12V    | 12 V voltage supplied by<br>the mainboard to the<br>drive backplane | Mainboard   |
| CPUN DDR VDDQ  | 1.2 V memory module voltage   | Mainboard  N indicates the CPU number. The value is 1 or 2. |
| CPUN DDR VDDQ2 | 1.2 V memory module voltage   | Mainboard  N indicates the CPU number. The value is 1 or 2. |
| CPUN VCCIN     | CPU VCCIN voltage   | Mainboard  N indicates the CPU number. The value is 1 or 2. |
| CPUN VSA       | CPU VSA voltage   | Mainboard  N indicates the CPU number. The value is 1 or 2. |
| CPUN P1V8      | CPU P1V8 voltage  | Mainboard  N indicates the CPU number. The value is 1 or 2. |
| CPUN VCCIO     | CPU VCCIO voltage   | Mainboard  N indicates the CPU number. The value is 1 or 2. |
| CPUN VCCANA    | CPU VCCANA voltage  | Mainboard  N indicates the CPU number. The value is 1 or 2. |
| FANN Speed     | Fan speed   | Fan module <i>N</i>   |
| FANN F Speed   |   | N indicates the fan module number. The                      |
| FANN R Speed   |   | value ranges from <b>1</b> to <b>4</b> .                    |
| Power          | Server input power  | Power supply unit (PSU)                                     |
| PSN VIN        | PSU N input voltage   | PSU <i>N N</i> indicates the PSU                            |
|                |   | number. The value is <b>1</b> or <b>2</b> .                 |

| Sensor         | Description   | Component   |
|----------------|---|---|
| Disks Temp     | Maximum drive temperature   | Drive   |
| Power <i>N</i> | PSU input power   | PSU N N indicates the PSU number. The value is 1 or 2.  |
| PCH Status     | PCH chip fault diagnosis health status  | Mainboard   |
| CPUN UPI Link  | CPU UPI link fault<br>diagnosis health status                                 | Mainboard or CPU N N indicates the CPU number. The value is 1 or 2.   |
| CPUN Prochot   | CPU Prochot   | CPUN  N indicates the CPU number. The value is 1 or 2.  |
| CPUN Status    | CPU status  | CPUN  N indicates the CPU  number. The value is 1 or 2.   |
| CPUN Memory    | Status of the memory corresponding to the CPU                                 | Memory module corresponding to CPU <i>N N</i> indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| FANN Status    | Fan fault status  | Fan module <i>N</i>   |
| FANN F Status  |   | N indicates the fan module number. The  |
| FANN R Status  |   | value ranges from <b>1</b> to <b>4</b> .  |
| DIMMN          | DIMM status   | DIMM <i>N N</i> indicates the DIMM slot number.   |
| RTC Battery    | RTC battery status. An alarm is generated when the voltage is lower than 1 V. | RTC battery on the mainboard  |
| PCIE Status    | PCIe status error   | PCIe card   |
| Power Button   | Power button pressed  | Mainboard and power button  |
| Watchdog2      | Watchdog  | Mainboard   |

| Sensor              | Description                           | Component  |
|---------------------|---------------------------------------|--|
| Mngmnt Health       | Management subsystem health status    | Management modules   |
| UID Button          | UID button status                     | Mainboard  |
| PwrOk Sig. Drop     | Voltage dip status                    | Mainboard  |
| PwrOn TimeOut       | Power-on timeout                      | Mainboard  |
| PwrCap Status       | Power capping status                  | Mainboard  |
| HDD Backplane       | Hardware presence                     | Drive backplane  |
| HDD BP Status       | Drive backplane health status         | Drive backplane  |
| Riser <i>N</i> Card | Hardware presence                     | Riser card <i>N N</i> indicates the riser card slot number. The value ranges from <b>1</b> to <b>3</b> . |
| SAS Cable           | Hardware presence                     | SAS high-speed cable on the mainboard  |
| FANN Presence       | Fan presence                          | Fan module <i>N</i>  |
| FANN F Presence     |                                       | N indicates the fan module number. The   |
| FANN R Presence     |                                       | value ranges from 1 to 4.  |
| RAID Presence       | RAID presence                         | RAID controller card   |
| LCD Status          | LCD health status                     | LCD  |
| LCD Presence        | LCD presence                          | LCD  |
| PS Redundancy       | Redundancy failure due to PSU removal | Power supply unit (PSU)  |
| PSN Status          | PSU status                            | PSU N N indicates the PSU number. The value is 1 or 2.   |
| PSN Fan Status      | PSU fan fault status                  | PSU N N indicates the PSU number. The value is 1 or 2.   |
| PSN Temp Status     | PSU presence                          | PSU <i>N N</i> indicates the PSU number. The value is <b>1</b> or <b>2</b> .                             |
| DISK\$              | Disk status                           | Drive  |

| Sensor            | Description   | Component                                  |
|-------------------|---|--|
| PCIe RAID\$ Temp  | Temperature of the PCIe RAID controller card                      | PCIe RAID controller card                  |
| M2 Temp(PCIe\$)   | Maximum temperature of all M.2 drives of the RAID controller card | PCIe RAID controller card                  |
| RAID Temp         | Temperature of the RAID controller card                           | RAID controller card                       |
| RAID Status       | RAID controller card health status                                | RAID controller card                       |
| RAID PCIE ERR     | Health status of the RAID controller card in fault diagnosis      | RAID controller card                       |
| IB\$ Temp         | IB NIC temperature  | IB card                                    |
| PCIe\$ OP Temp    | PCIe card optical module temperature                              | PCle card                                  |
| PCIe NIC\$ Temp   | PCle card chip temperature  | PCle card                                  |
| PCIe FC\$ Temp    | PCIe card chip temperature  | PCle card                                  |
| RAID Card BBU     | RAID controller card BBU  | BBU supercapacitor of RAID controller card |
| FPGA\$ Temp       | FPGA card temperature   | PCle card                                  |
| FPGA\$ DDR Temp   | FPGA card memory temperature                                      | PCle card                                  |
| FPGA\$ Power      | FPGA card power   | PCIe card                                  |
| FPGA\$ OP Temp    | FPGA card optical module temperature                              | PCle card                                  |
| PCIe\$ Inlet Temp | PCIe smart card air inlet temperature                             | PCle smart cards                           |
| PCIe\$ Cpu Temp   | PCIe smart card CPU temperature                                   | PCle smart cards                           |
| 1711 Core Temp    | Core temperature of the BMC management chip                       | BMC card                                   |
| PS\$ IIn          | PSU input current   | Power supply unit (PSU)                    |
| PS\$ IOut         | PSU output current  | Power supply unit (PSU)                    |
| PS\$ Pout         | PSU output power  | Power supply unit (PSU)                    |

| Sensor          | Description   | Component   |
|-----------------|---|---|
| PS\$ Temp       | Maximum internal temperature of the PSU                                 | Power supply unit (PSU)   |
| PS\$ Inlet Temp | PSU air inlet temperature   | Power supply unit (PSU)   |
| AreaIntrusion   | Listening to the unpacking action                                       | Mainboard   |
| OCP\$ OP Temp   | OCP card optical module temperature                                     | OCP 3.0 Network<br>Adapters   |
| OCP\$ Temp      | OCP card chip temperature   | OCP 3.0 Network<br>Adapters   |
| CPUN PMem Temp  | CPU PMem module temperature   | PMem module corresponding to CPU <i>N N</i> indicates the CPU number. The value is <b>1</b> or <b>2</b> . |
| Riser\$ Temp    | Riser card temperature  | Riser cards   |
| Disk BP\$ Temp  | Drive backplane temperature   | Drive backplane   |
| SSD Max Temp    | Maximum SSD temperature   | SSD   |
| RAID BBU Temp   | RAID controller card capacitor temperature                              | Supercapacitor of the RAID controller card  |
| PCIe\$ Temp     | PCle card chip temperature  | PCle card   |
| PCle\$ Card BBU | BBU status of the PCle<br>RAID controller card                          | PCle RAID controller card   |
| GPU\$ Power     | GPU card power  | GPU cards   |
| GPU\$ Temp      | GPU temperature   | GPU cards   |
| GPU\$ MINI Temp | Mini chip temperature of the GPU card                                   | GPU cards   |
| GPU\$ DDR Temp  | DDR chip temperature of the GPU card                                    | GPU cards   |
| GPU\$ HBM Temp  | HBM chip temperature of the GPU card                                    | GPU cards   |
| System Notice   | Hot restart reminder and fault diagnosis program information collection | N/A   |

| Sensor           | Description  | Component |
|------------------|--|-----------|
| System Error     | System suspension or restart. Check the background logs. |           |
| ACPI State       | ACPI status  |           |
| SysFWProgress    | Software process and system startup errors               |           |
| SysRestart       | Cause of system restart                                  |           |
| Boot Error       | Boot error   |           |
| CPU Usage        | CPU usage.   |           |
| Memory Usage     | Memory usage.  |           |
| BMC Boot Up      | BMC startup events                                       |           |
| BMC Time Hopping | Time hopping   |           |
| NTP Sync Failed  | NTP synchronization failure and recovery events          |           |
| SEL Status       | SEL full or clearing events                              |           |
| Op. Log Full     | Operation log full or clearing events                    |           |
| Sec. Log Full    | Security log full or clearing events                     |           |
| Host Loss        | System monitoring software (BMA) link loss detection     |           |
| ProductID Status | Product identification status                            |           |
| OAMPort1_\$ Link | Network port OAM link status                             |           |
| OAMPort2_\$ Link | Network port OAM link status                             |           |

# B Glossary

#### **B.1 A-E**

В

| ВМС | The baseboard management controller (BMC) complies with the Intelligent Platform Management Interface (IPMI). It collects, processes, and stores sensor signals, and monitors the operating status of components. The BMC provides the hardware status and alarm information about the managed objects to the upper-level |
|-----|---|
|     | management system, so that the management system can manage the objects.  |

Ε

| ejector lever | A part on the panel of a device used to facilitate installation or removal of the device.   |
|---------------|---|
| Ethernet      | A baseband local area network (LAN) architecture developed by Xerox Corporation by partnering with Intel and DEC. Ethernet uses the Carrier Sense Multiple Access/Collision Detection (CSMA/CD) access method and allows data transfer over various cables at 10 Mbit/s. The Ethernet specification is the basis for the IEEE 802.3 standard. |

# **B.2 F-J**

G

| Gigabit Ethernet (GE) | An extension and enhancement of traditional shared media Ethernet standards. It is compatible with 10 Mbit/s and 100 Mbit/s Ethernet and complies with IEEE 802.3z |
|-----------------------|--|
|                       | standards.   |

Н

| hot swap | Replacing or adding components without stopping or |
|----------|--|
|          | shutting down the system.                          |

# **B.3 K-O**

Κ

| KVM | A hardware device that provides public video, keyboard and mouse (KVM). |
|-----|---|
|     |   |

# **B.4 P-T**

Ρ

| panel   | An external component (including but not limited to ejector levers, indicators, and ports) on the front or rear of the server. It seals the front and rear of the chassis to ensure optimal ventilation and electromagnetic compatibility (EMC).  |
|---|---|
| Peripheral<br>Component<br>Interconnect Express<br>(PCIe) | A computer bus PCI, which uses the existing PCI programming concepts and communication standards, but builds a faster serial communication system. Intel is the main sponsor for PCIe. PCIe is used only for internal interconnection. A PCI system can be transformed to a PCIe system by modifying the physical layer instead of software. PCIe delivers a faster speed and can replace almost all AGP and PCI buses. |

#### R

| redundancy                                  | A mechanism that allows a backup device to automatically take over services from a faulty device to ensure uninterrupted running of the system.  |
|---|--|
| redundant array of independent disks (RAID) | A storage technology that combines multiple physical drives into a logical unit for the purposes of data redundancy and performance improvement. |

#### S

| server                    | A special computer that provides services for clients over a network.                       |
|---------------------------|---|
| system event log<br>(SEL) | Event records stored in the system used for subsequent fault diagnosis and system recovery. |

# **B.5 U-Z**

U

| U                               | A unit defined in International Electrotechnical<br>Commission (IEC) 60297-1 to measure the height of a<br>cabinet, chassis, or subrack. 1 U = 44.45 mm |
|---------------------------------|---|
| UltraPath<br>Interconnect (UPI) | A point-to-point processor interconnect developed by Intel.   |

# C Acronyms and Abbreviations

#### **C.1 A-E**

A

| AC  | alternating current                              |
|-----|--|
| AES | Advanced Encryption Standard New Instruction Set |
| ARP | Address Resolution Protocol                      |
| AVX | Advanced Vector Extensions                       |

В

| BBU  | backup battery unit             |
|------|---------------------------------|
| BIOS | Basic Input/Output System       |
| вмс  | baseboard management controller |

C

| ccc | China Compulsory Certification |
|-----|--------------------------------|
| CD  | calendar day                   |
| CE  | Conformite Europeenne          |
| СІМ | Common Information Model       |
| CLI | command-line interface         |

D

| DC   | direct current                       |
|------|--------------------------------------|
| DDR4 | Double Data Rate 4                   |
| DDDC | double device data correction        |
| DEMT | Dynamic Energy Management Technology |
| DIMM | dual in-line memory module           |
| DRAM | dynamic random-access memory         |
| DVD  | digital video disc                   |

Ε

| ECC  | error checking and correcting              |
|------|--|
| ECMA | European Computer Manufacturer Association |
| EDB  | Execute Disable Bit                        |
| EID  | Enclosure ID                               |
| EN   | European Efficiency                        |
| ERP  | enterprise resource planning               |
| ETS  | European Telecommunication Standards       |

# C.2 F-J

F

| FB-DIMM | Fully Buffered DIMM               |
|---------|-----------------------------------|
| FC      | Fiber Channel                     |
| FCC     | Federal Communications Commission |
| FCoE    | Fibre Channel over Ethernet       |
| FTP     | File Transfer Protocol            |

G

| GE | Gigabit Ethernet |
|----|------------------|
|----|------------------|

| GPIO | General Purpose Input/Output |
|------|------------------------------|
| GPU  | graphics processing unit     |

#### Н

| НА    | high availability                  |
|-------|------------------------------------|
| HDD   | hard disk drive                    |
| HPC   | high-performance computing         |
| НТТР  | Hypertext Transfer Protocol        |
| HTTPS | Hypertext Transfer Protocol Secure |

I

| іВМС | intelligent baseboard management controller       |
|------|---|
| IC   | Industry Canada                                   |
| ICMP | Internet Control Message Protocol                 |
| IDC  | Internet Data Center                              |
| IEC  | International Electrotechnical Commission         |
| IEEE | Institute of Electrical and Electronics Engineers |
| IGMP | Internet Group Message Protocol                   |
| IOPS | input/output operations per second                |
| IP   | Internet Protocol                                 |
| IPC  | Intelligent Power Capability                      |
| IPMB | Intelligent Platform Management Bus               |
| IPMI | Intelligent Platform Management Interface         |

# C.3 K-O

#### Κ

| KVM | keyboard, video, and mouse |
|-----|----------------------------|
|-----|----------------------------|

L

| LC     | Lucent Connector                        |
|--------|---|
| LRDIMM | load-reduced dual in-line memory module |
| LED    | light emitting diode                    |
| LOM    | LAN on motherboard                      |

M

| MAC | media access control         |
|-----|------------------------------|
| ммс | module management controller |

Ν

| NBD   | next business day                     |
|-------|---------------------------------------|
| NC-SI | Network Controller Sideband Interface |

0

| ОСР | Open Compute Project |
|-----|----------------------|
|-----|----------------------|

### **C.4 P-T**

Ρ

| PCle  | Peripheral Component Interconnect Express |
|-------|---|
| PDU   | power distribution unit                   |
| PHY   | physical layer                            |
| PMBUS | power management bus                      |
| РОК   | Power OK                                  |
| PWM   | pulse-width modulation                    |
| PXE   | Preboot Execution Environment             |

#### R

| RAID  | redundant array of independent disks  |
|-------|---|
| RAS   | reliability, availability and serviceability  |
| RDIMM | registered dual in-line memory module   |
| REACH | Registration Evaluation and Authorization of Chemicals  |
| RJ45  | registered jack 45  |
| RoHS  | Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment |

S

| SAS    | Serial Attached Small Computer System Interface                 |
|--------|---|
| SATA   | Serial Advanced Technology Attachment                           |
| SCM    | supply chain management   |
| SDDC   | single device data correction                                   |
| SERDES | serializer/deserializer   |
| SGMII  | serial gigabit media independent interface                      |
| SMI    | serial management interface                                     |
| SMTP   | Simple Mail Transfer Protocol                                   |
| SNMP   | Simple Network Management Protocol                              |
| SOL    | serial over LAN   |
| SONCAP | Standards Organization of Nigeria-Conformity Assessment Program |
| SSD    | solid-state drive   |
| SSE    | Streaming SIMD Extension  |

T

| TACH | tachometer signal           |
|------|-----------------------------|
| ТВТ  | Turbo Boost Technology      |
| TCG  | Trusted Computing Group     |
| TCM  | trusted cryptography module |
| тсо  | total cost of ownership     |

| TDP    | thermal design power               |
|--------|------------------------------------|
| TELNET | Telecommunication Network Protocol |
| TET    | Trusted Execution Technology       |
| TFM    | TransFlash module                  |
| TFTP   | Trivial File Transfer Protocol     |
| TOE    | TCP offload engine                 |
| ТРМ    | trusted platform module            |

### **C.5 U-Z**

U

| UDIMM | unbuffered dual in-line memory module |
|-------|---------------------------------------|
| UEFI  | Unified Extensible Firmware Interface |
| UID   | unit identification light             |
| UL    | Underwriter Laboratories Inc.         |
| UPI   | UltraPath Interconnect                |
| USB   | Universal Serial Bus                  |

٧

| VCCI | Voluntary Control Council for Interference by Information Technology Equipment |
|------|--|
| VGA  | Video Graphics Array   |
| VLAN | virtual local area network   |
| VRD  | voltage regulator-down   |

W

| WEEE  | waste electrical and electronic equipment |
|-------|---|
| WSMAN | Web Service Management                    |